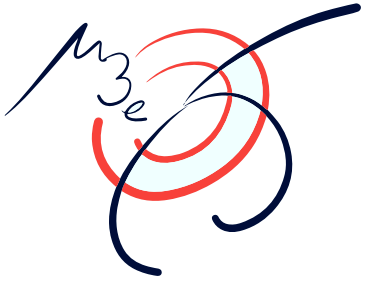
The Mu3e Experiment

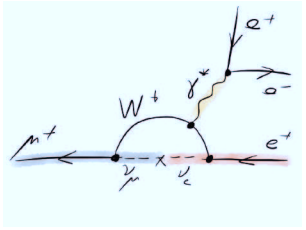


Niklaus Berger

Physikalisches Institut, Universität Heidelberg

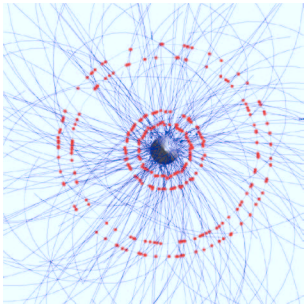
Lepton Moments 2014

Overview



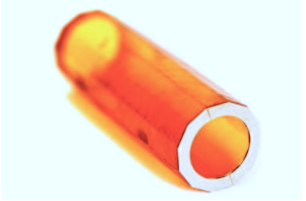
- The Charge:

  Can we find lepton flavour violating μ-decays?



- The Challenge:

  Finding one in 10^{16} muon decays

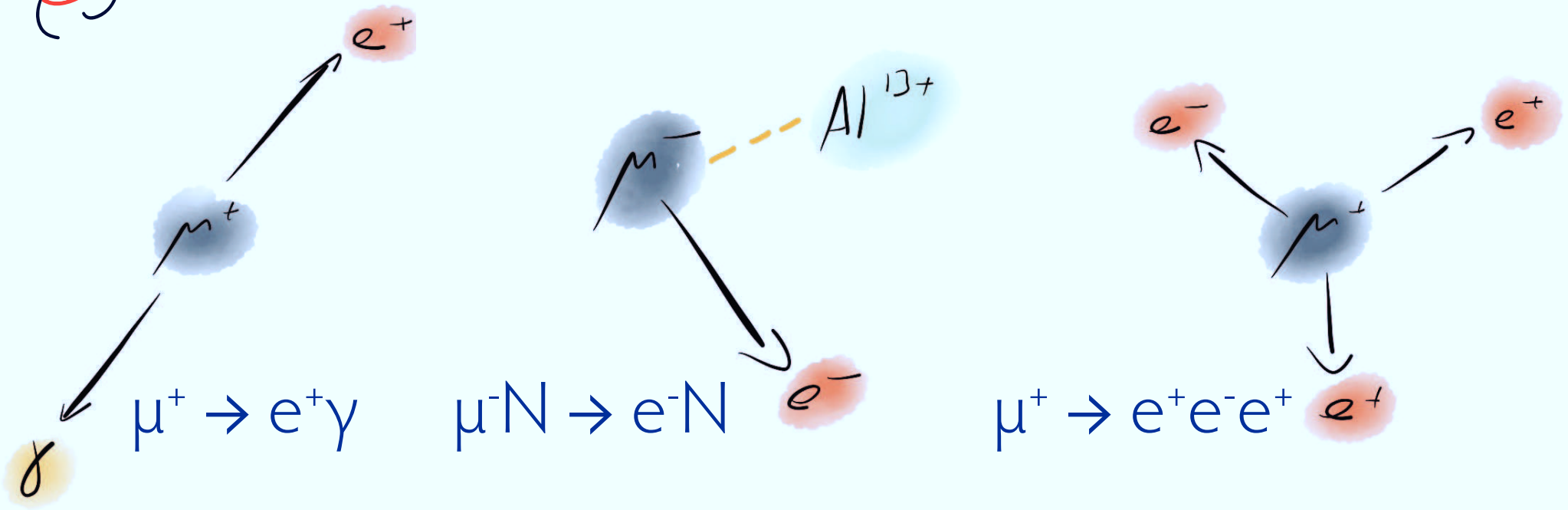


- The Mu3e Detector:

  Minimum Material, Maximum Precision

The hunt for
charged lepton flavour violation in μ-decays

LFV Muon Decays: Experimental Situation



$\mu^+ \to e^+\gamma$ $\mu^-N \to e^-N$ $\mu^+ \to e^+e^-e^+$

MEG (PSI)

$B(\mu^+ \to e^+\gamma) < 5.7 \cdot 10^{-13}$

(2013)

SINDRUM II (PSI)

$B(\mu^- Au \to e^- Au) < 7 \cdot 10^{-13}$

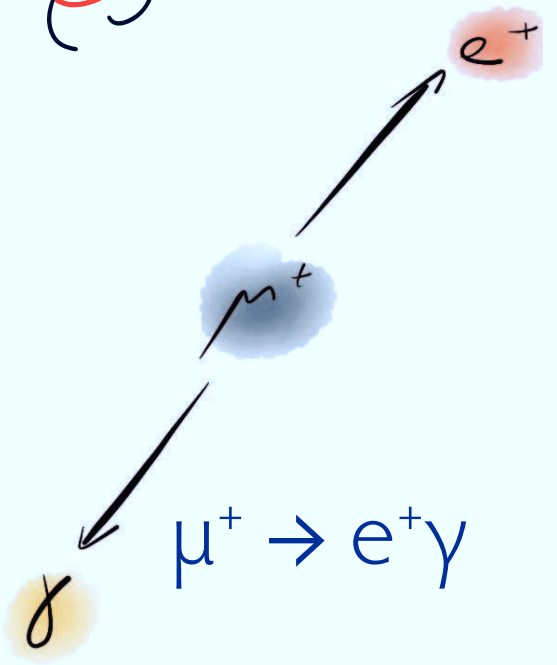
(2006)

SINDRUM (PSI)

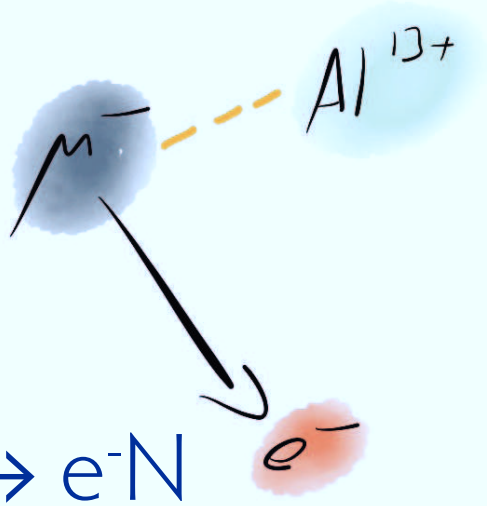
$B(\mu^+ \to e^+e^-e^+) < 1.0 \cdot 10^{-12}$

(1988)

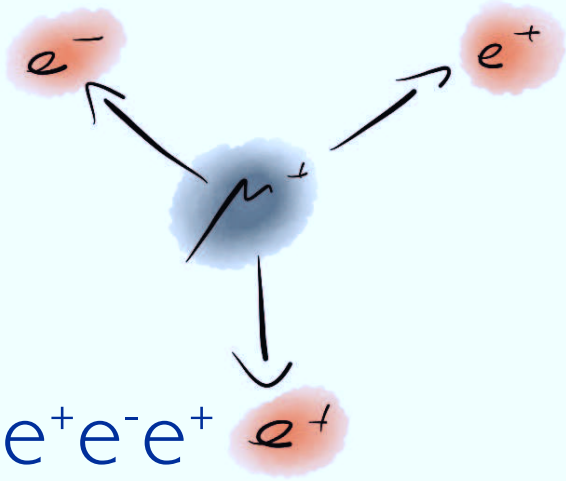
LFV Muon Decays: Experimental Situation



$\mu^+ \to e^+\gamma$



$\mu^-N \to e^-N$



$\mu^+ \to e^+e^-e^+$

MEG (PSI)

$B(\mu^+ \to e^+\gamma) < 5.7 \cdot 10^{-13}$

(2013)

upgrading

SINDRUM II (PSI)

$B(\mu^- Au \to e^- Au) < 7 \cdot 10^{-13}$

(2006)

Mu2e/Comet

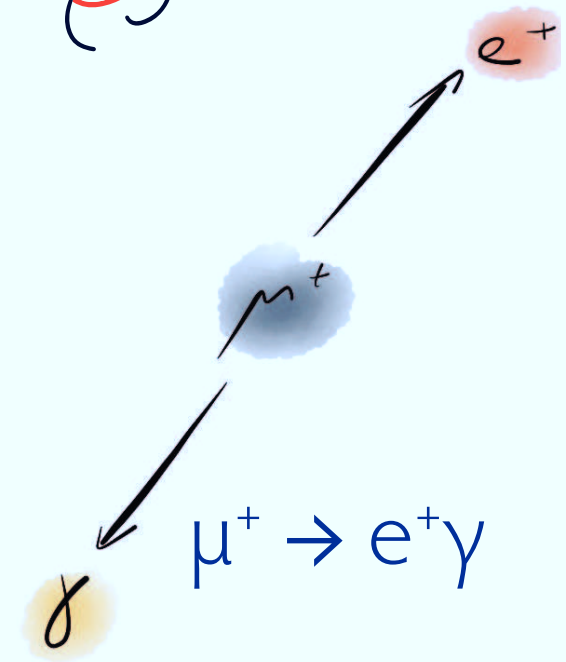
SINDRUM (PSI)

$B(\mu^+ \to e^+e^-e^+) < 1.0 \cdot 10^{-12}$

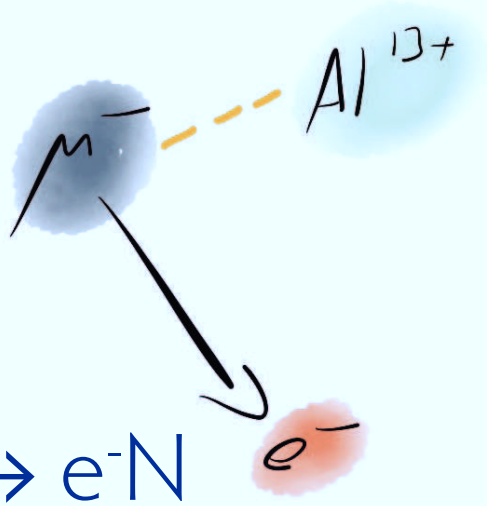
(1988)

Mu3e

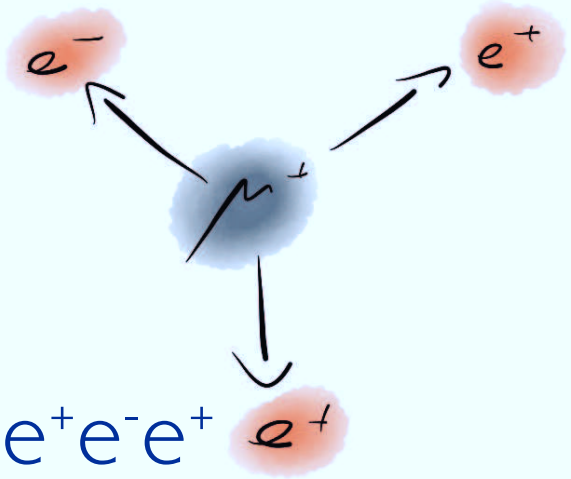
LFV Muon Decays: Experimental signatures



$\mu^+ \rightarrow e^+\gamma$



$\mu^-N \rightarrow e^-N$



$\mu^+ \rightarrow e^+e^-e^+$

Kinematics

- 2-body decay
- Monoenergetic e^+, γ
- Back-to-back

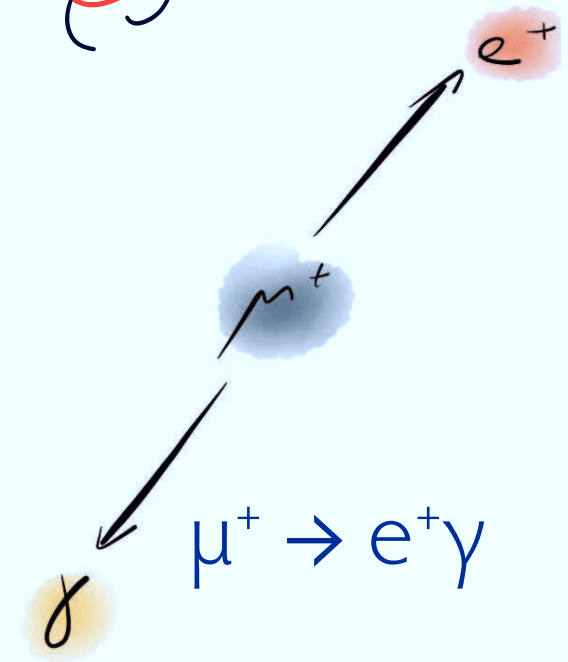
Kinematics

- Quasi 2-body decay
- Monoenergetic e^-
- Single particle detected

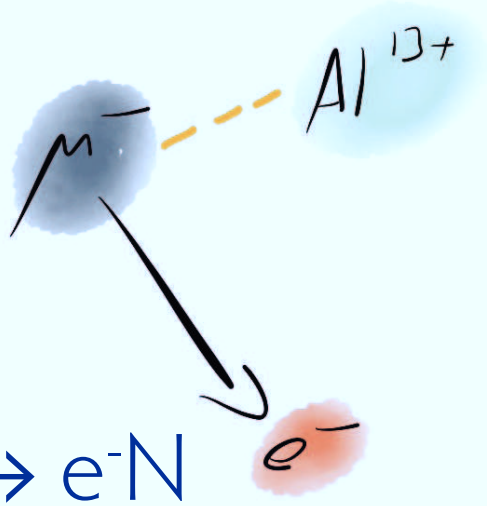
Kinematics

- 3-body decay
- Invariant mass constraint
- $\Sigma\, p_i = 0$

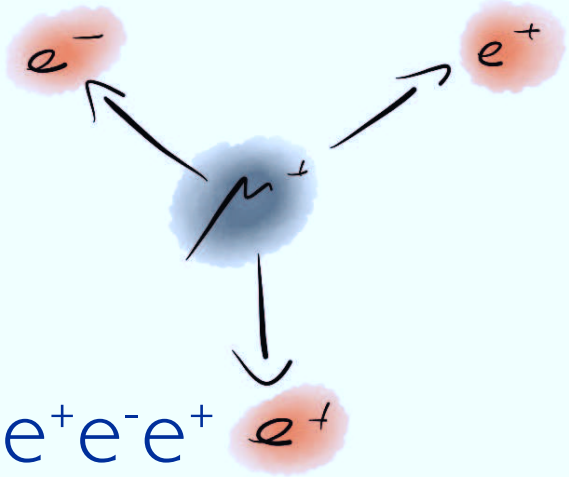
LFV Muon Decays: Experimental signatures



$\mu^+ \rightarrow e^+\gamma$



$\mu^-N \rightarrow e^-N$



$\mu^+ \rightarrow e^+e^-e^+$

Kinematics

- 2-body decay
- Monoenergetic e^+, γ
- Back-to-back

Background

- Accidental background

Kinematics

- Quasi 2-body decay
- Monoenergetic e^-
- Single particle detected

Background

- Decay in orbit
- Antiprotons, pions, cosmics

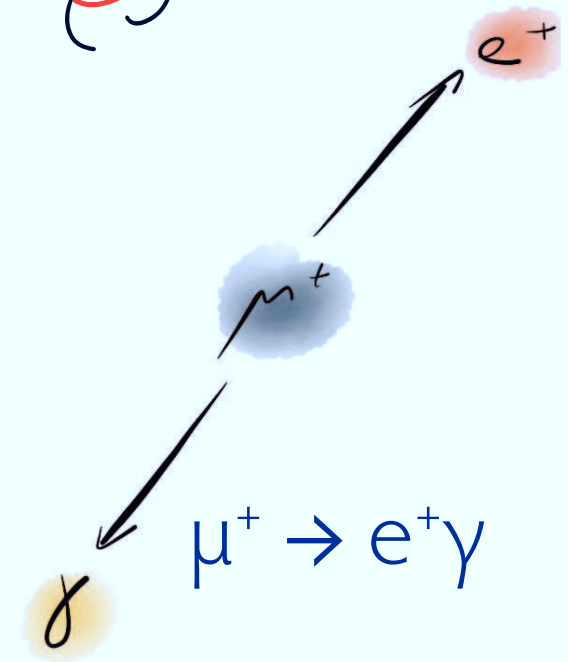
Kinematics

- 3-body decay
- Invariant mass constraint
- $\Sigma p_i = 0$

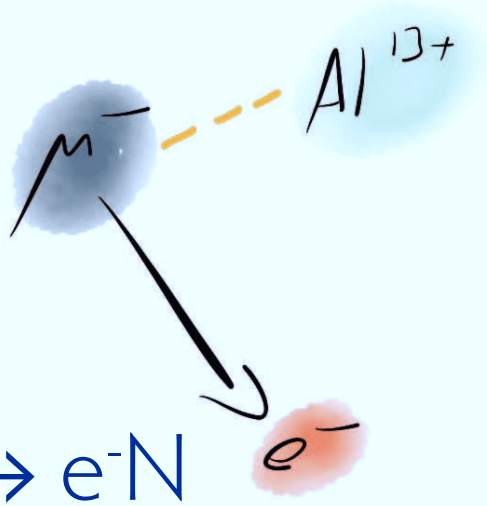
Background

- Radiative decay
- Accidental background

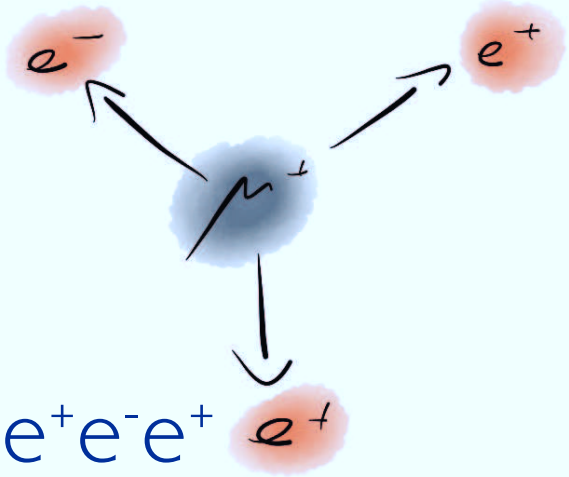
LFV Muon Decays: Experimental signatures



$\mu^+ \rightarrow e^+\gamma$



$\mu^-N \rightarrow e^-N$



$\mu^+ \rightarrow e^+e^-e^+$

Kinematics
- 2-body decay
- Monoenerge
- Back-to-b

Backgro
- A al background

Continuous Beam

Kinematics
- Quasi 2-body d
- Monoenerge
- Single pa etected

Backgro
- D orbit
- An protons, pions

Pulsed Beam

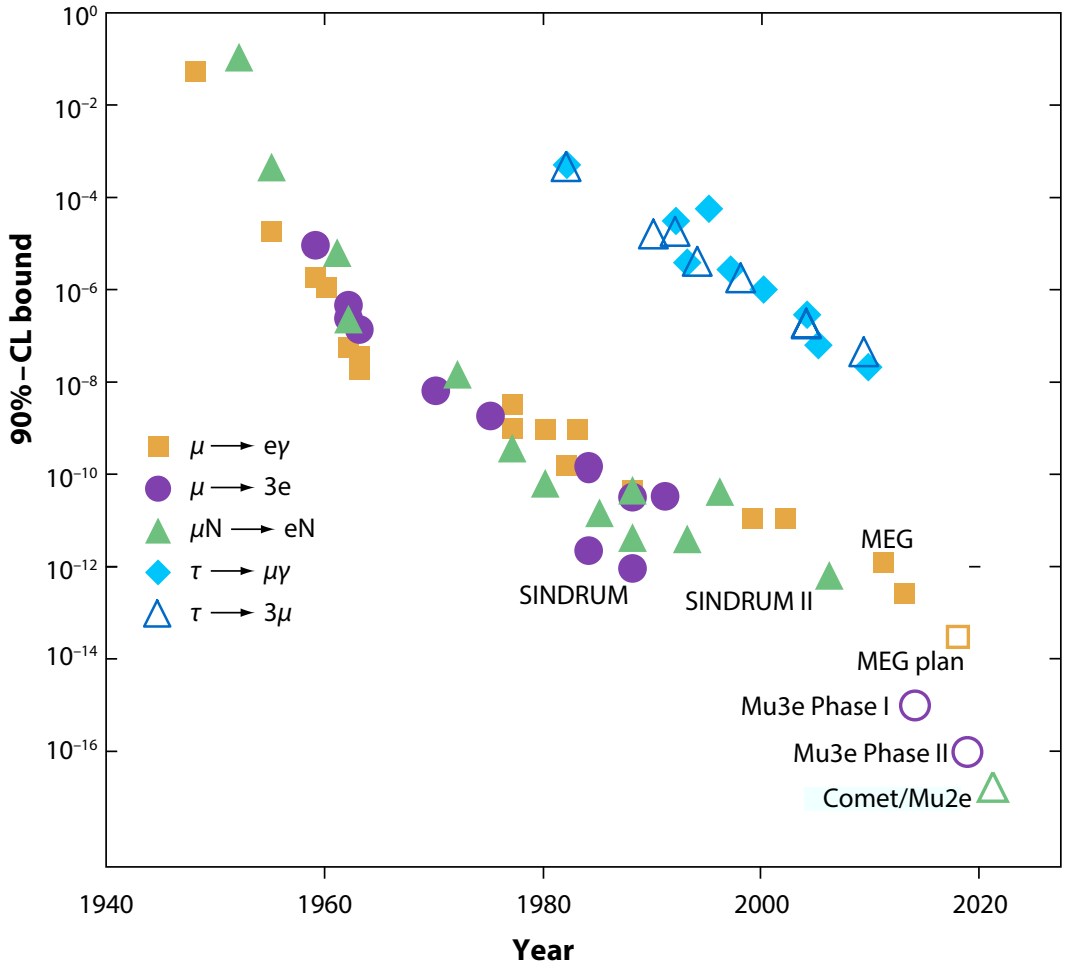
Kinematics
- 3-body decay
- Invariant mas aint
- $\Sigma p_i = 0$

Backgro
- R decay
- Ac dental background

Continuous Beam

Searching for
$\mu^+ \rightarrow e^+e^-e^+$ at the 10^{-16} level

The Goal: 10^{-16}



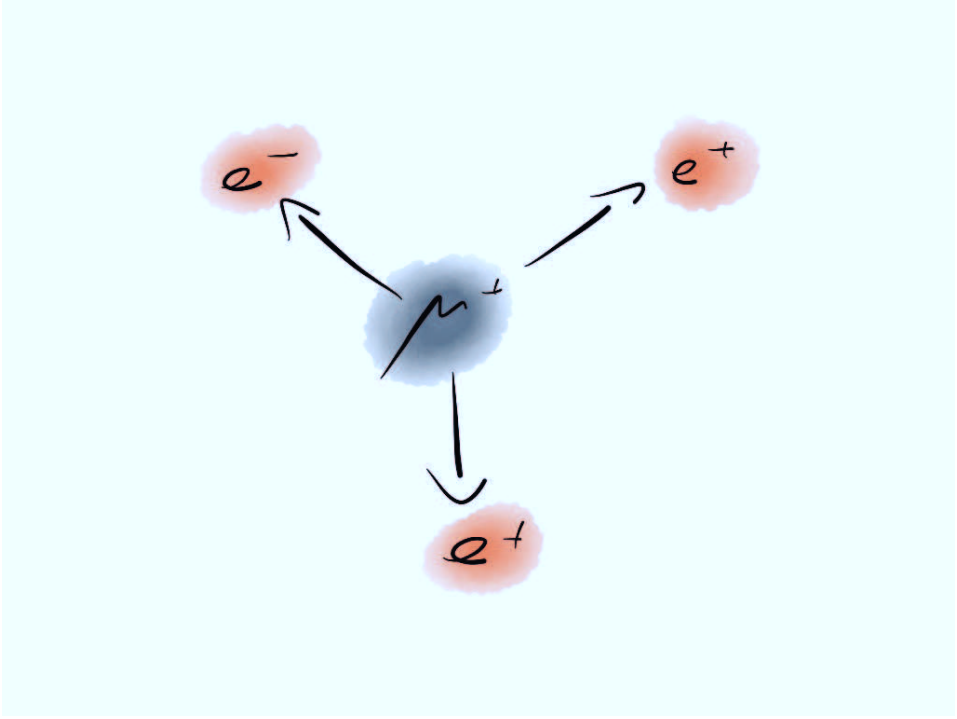
- We want to find or exclude μ → eee at the 10^{-16} level
- 10^{-15} in phase I (existing beamline)
- 10^{-16} in phase II (new beamline)
- 4 orders of magnitude over previous experiment (SINDRUM 1988)

(Updated from W.J. Marciano, T. Mori and J.M. Roney, Ann.Rev.Nucl.Part.Sci. 58, 315 (2008))

The Mu3e Collaboration

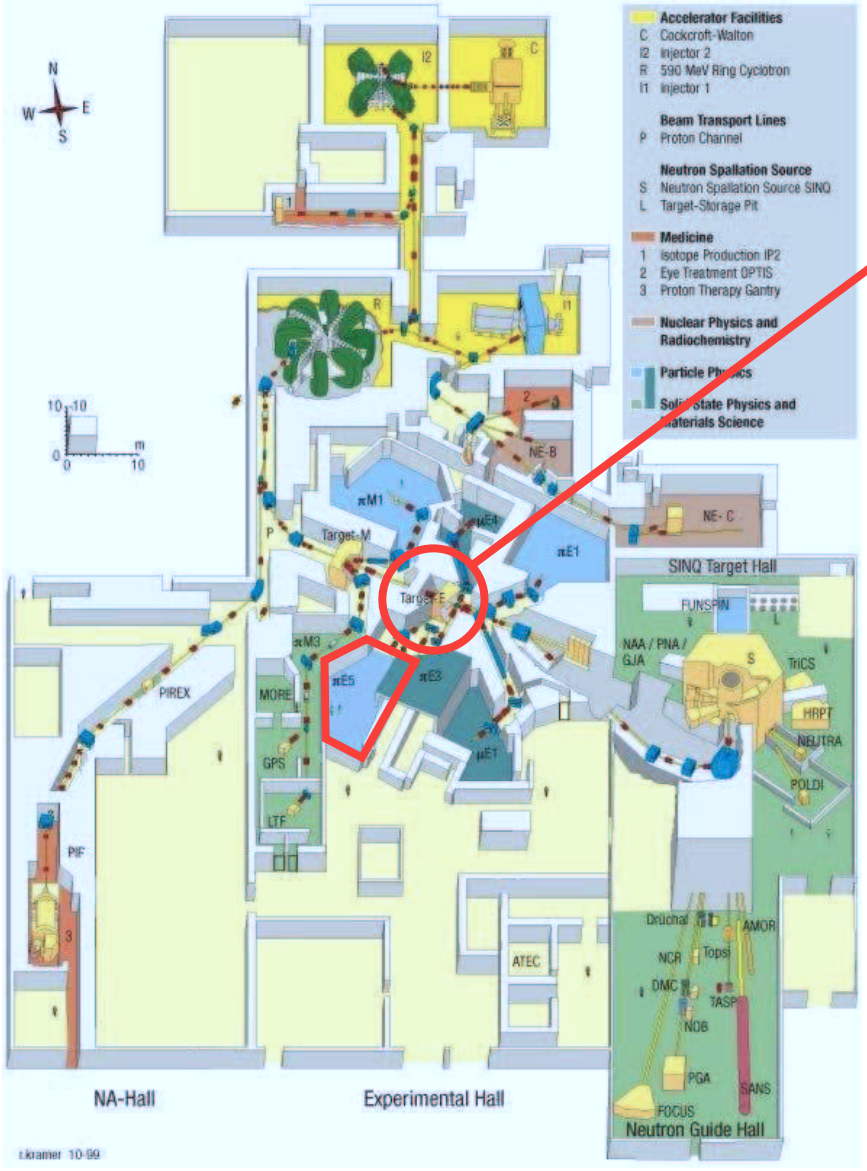
- DPNC, Geneva University
- Physics Institute, Heidelberg University
- KIP, Heidelberg University
- ZITI Mannheim, Heidelberg University
- Paul Scherrer Institute
- Physics Institute, Zürich University
- Institute for Particle Physics, ETH Zürich

The Challenges



- Observe more than 10^{16} muon decays:
  2 Billion muons per second
- Suppress backgrounds by more than 16 orders of magnitude
- Be sensitive for the signal

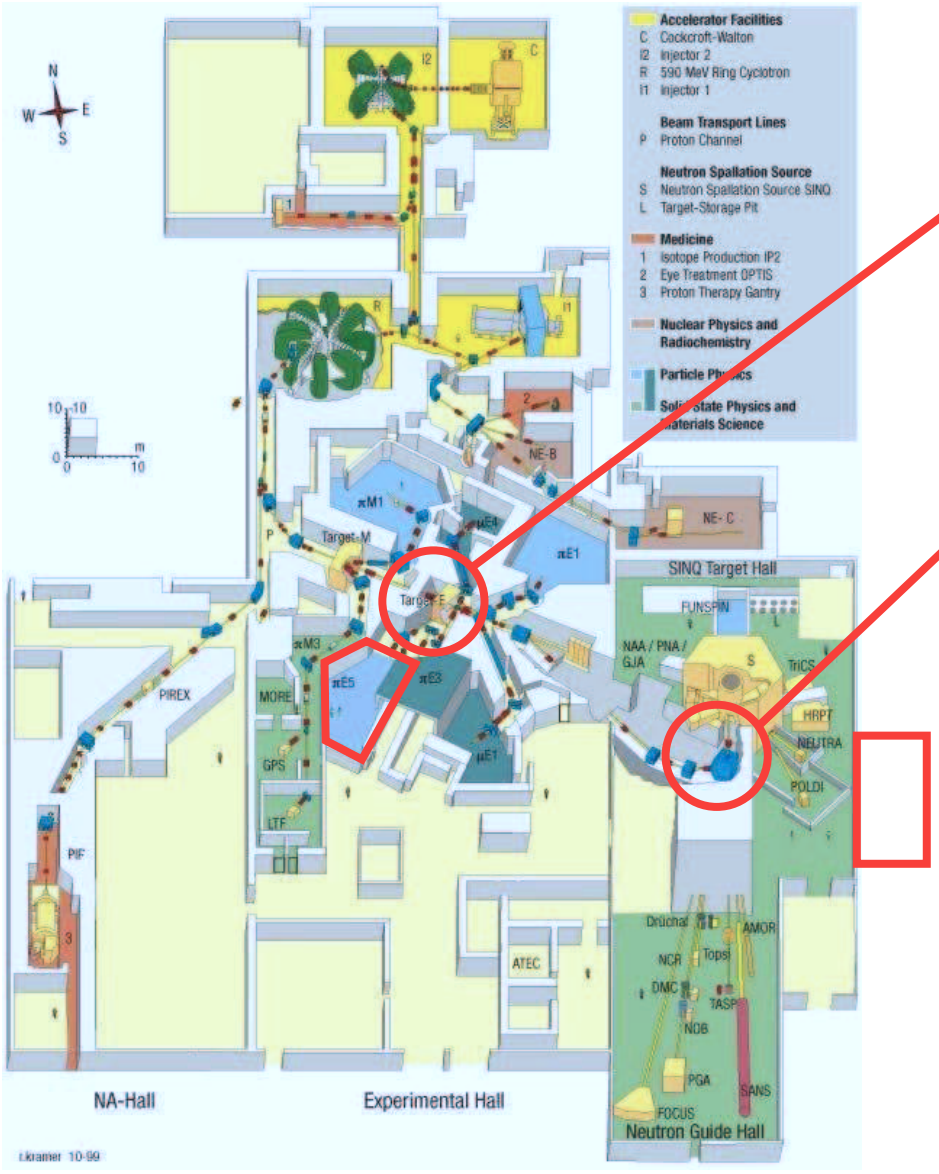
Muons from PSI



DC muon beams at PSI:

- πE5 beamline: ~ 10^8 muons/s
  (MEG experiment, Mu3e phase I)

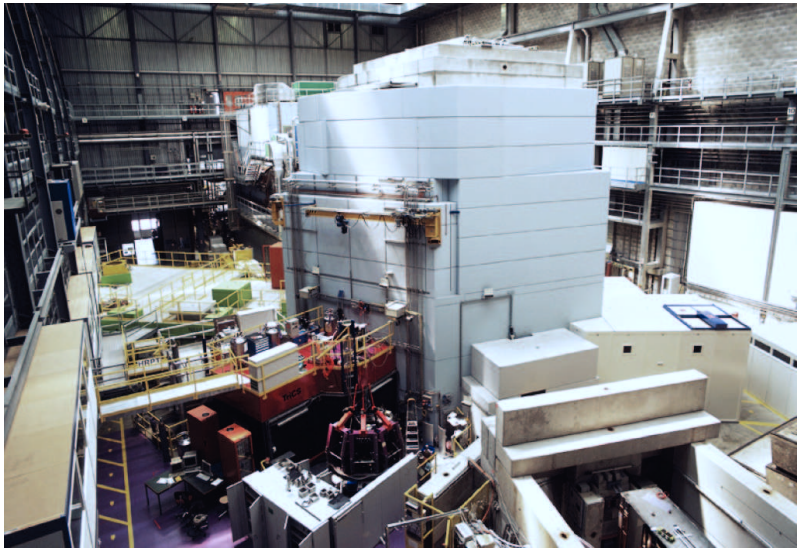
Muons from PSI



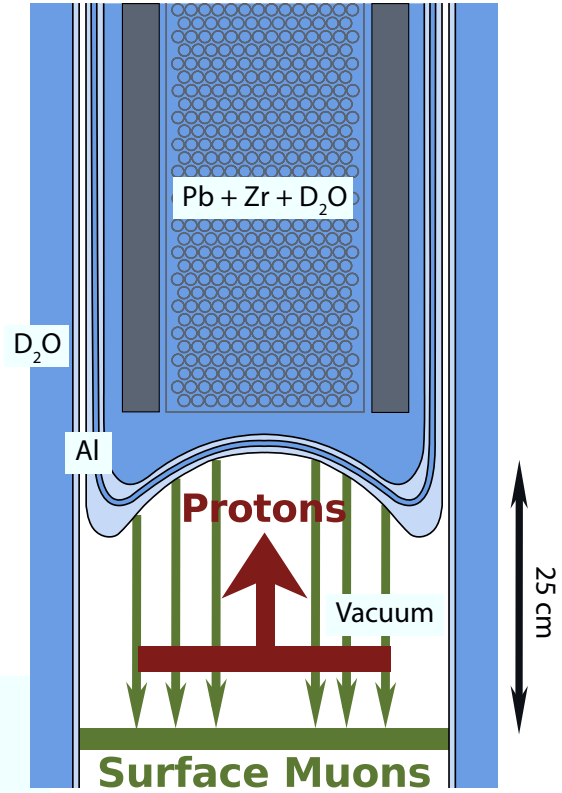
DC muon beams at PSI:

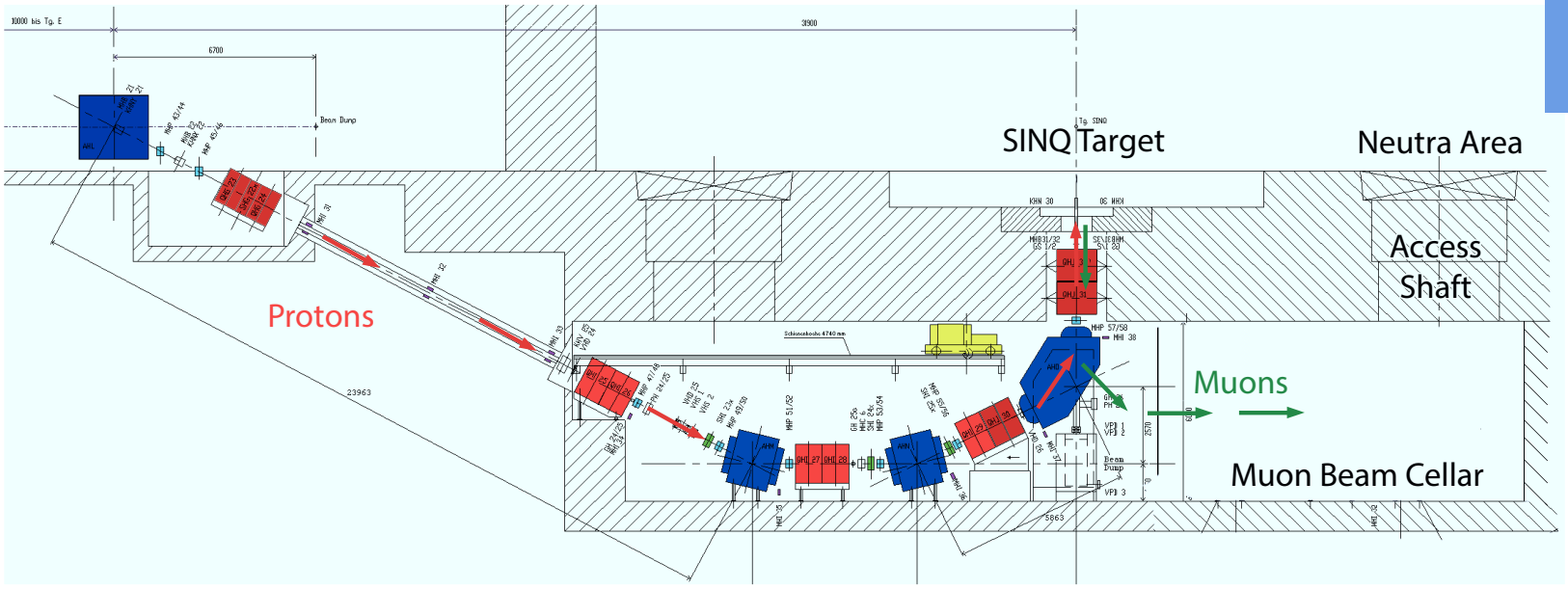
- πE5 beamline: ~ 10^8 muons/s
  (MEG experiment, Mu3e phase I)
- At the SINQ (spallation neutron source) more than ~ 5 × 10^{10} muons/s are produced
  High intensity muon beamline (HiMB) proposal
- The μ → eee experiment (final stage) requires 2 × 10^9 muons/s focused and collimated on a ~2 cm spot

The High-Intensity Muon Beamline (HIMB)

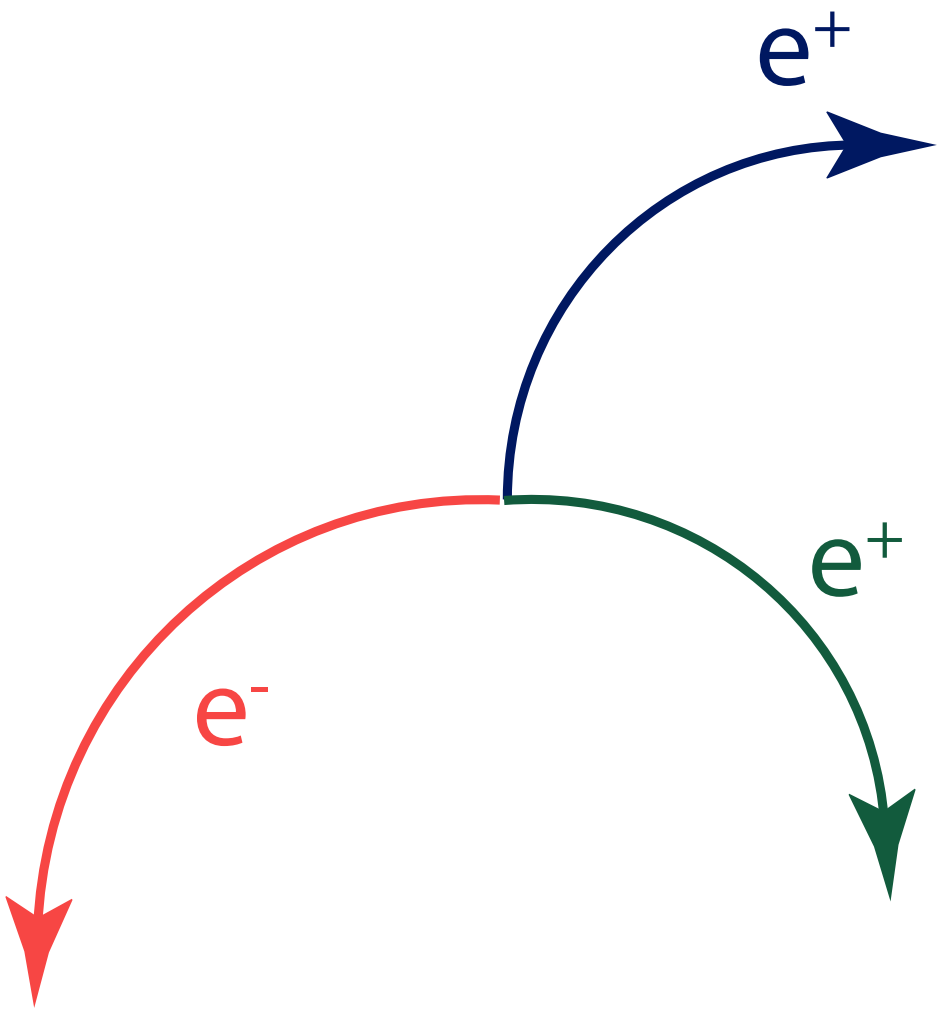


- Muon rates in excess of 10^{10}/s
- $2 \cdot 10^{9}$/s needed for $\mu \rightarrow eee$ at 10^{-16}
- Not before 2019



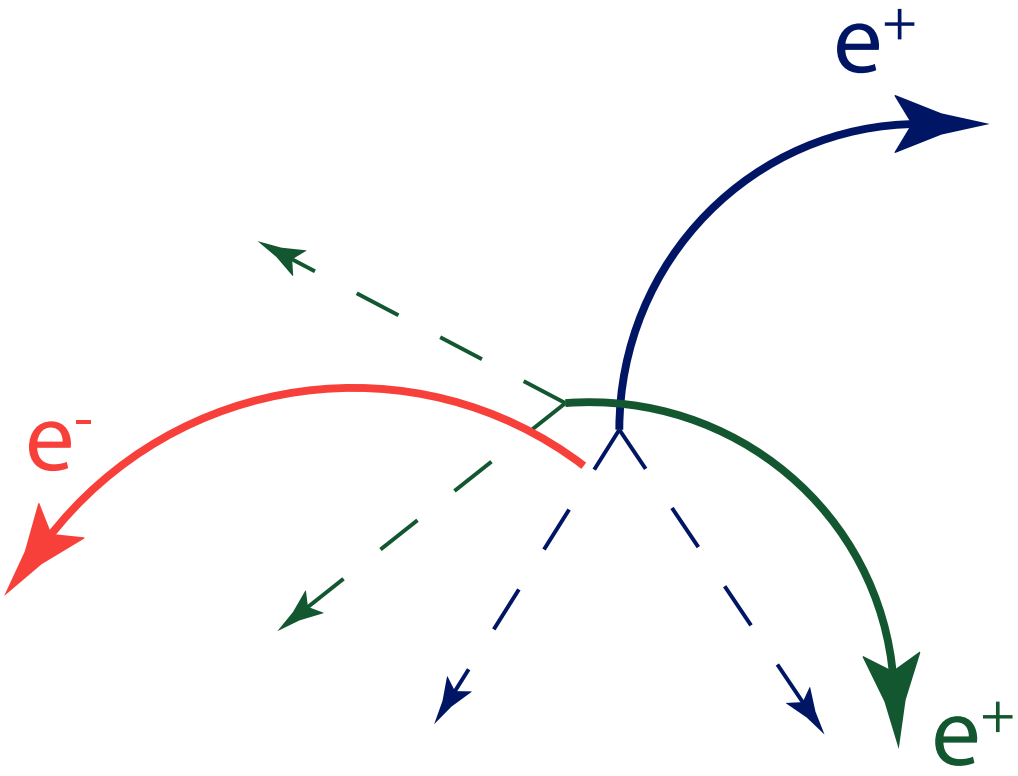


The signal



- $\mu^+ \rightarrow e^+e^-e^+$
- Two positrons, one electron
- From same vertex
- Same time
- Sum of 4-momenta corresponds to muon at rest
- Maximum momentum: ½ m_μ = 53 MeV/c

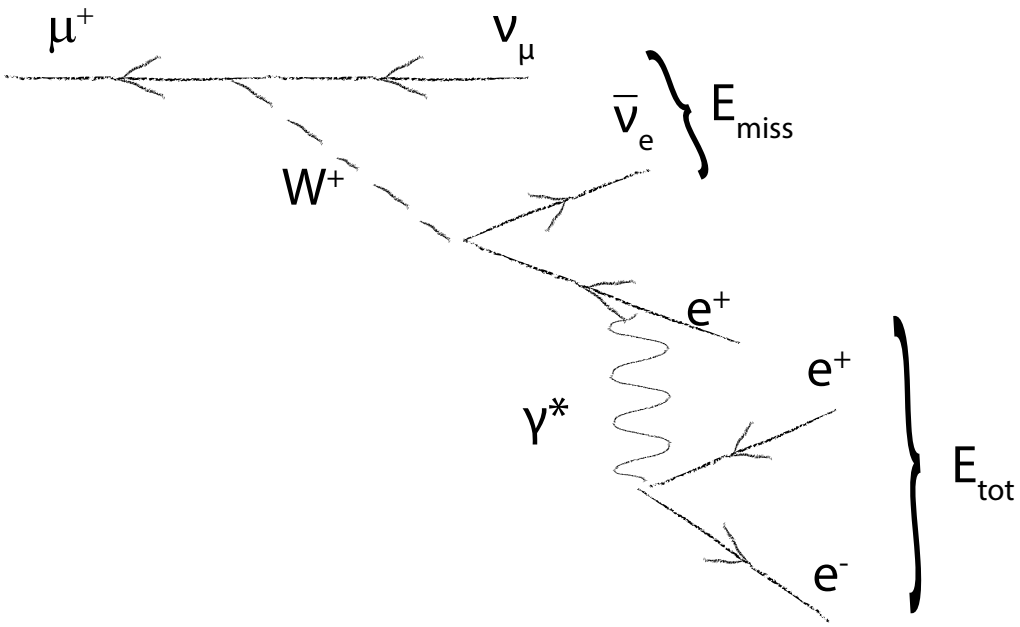
Accidental Background



- Combination of positrons from ordinary muon decay with electrons from:
  - photon conversion,
  - Bhabha scattering,
  - Mis-reconstruction

- Need very good timing, vertex and momentum resolution

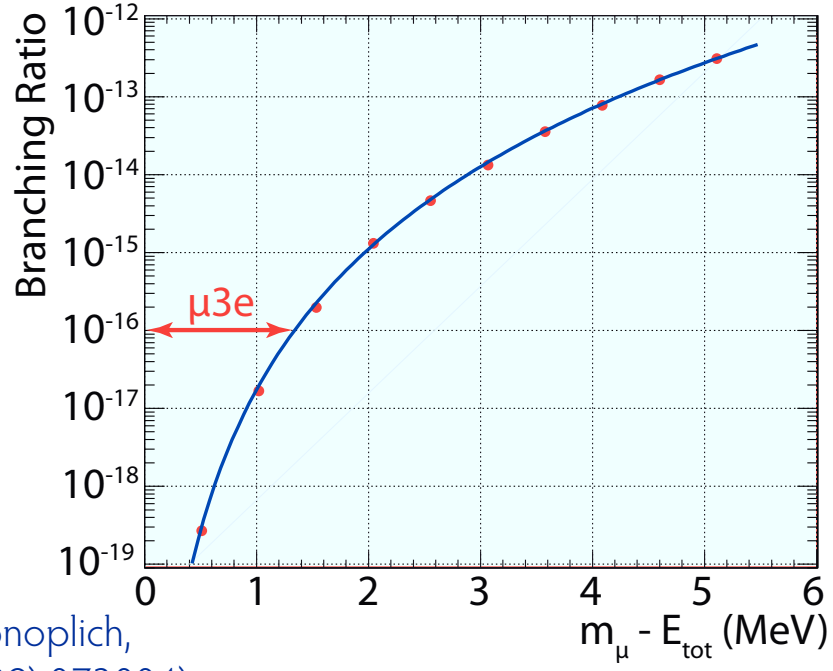
Internal conversion background



- Allowed radiative decay with internal conversion:

$$\mu^+ \rightarrow e^+e^-e^+\nu\bar{\nu}$$

- Only distinguishing feature: Missing momentum carried by neutrinos

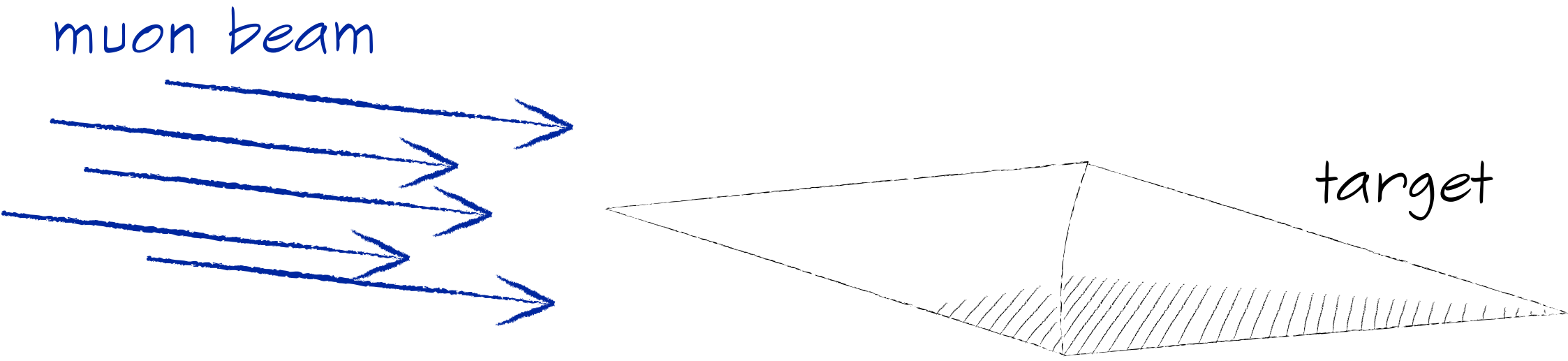


- Need excellent momentum resolution

(R. M. Djilkibaev, R. V. Konoplich, Phys.Rev. D79 (2009) 073004)

Building the Mu3e Experiment

2 Billion Muons/s



2 Billion Muon Decays/s

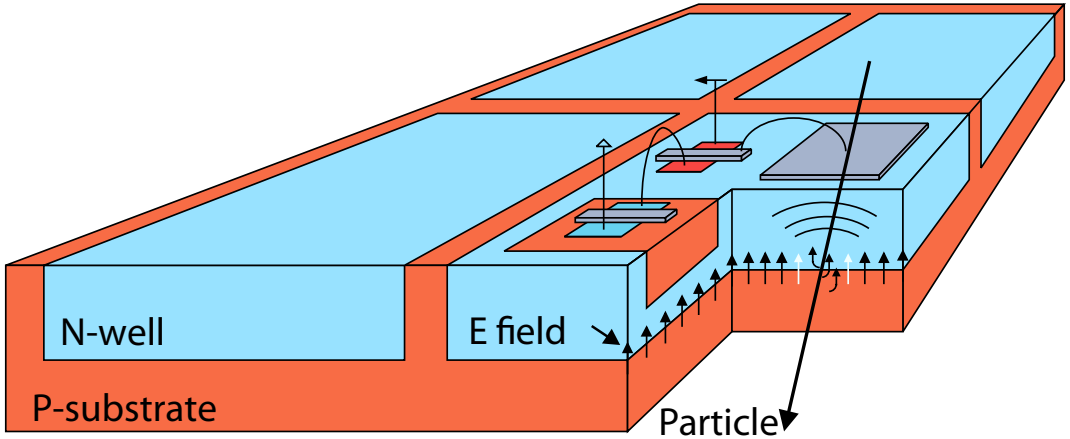
50 ns, 1 Tesla field

Detector Technology

- High granularity
  (occupancy)
- Close to target
  (vertex resolution)
- 3D space points
  (reconstruction)
- Minimum material
  (momenta below 53 MeV/c)

- Gas detectors do not work
  (space charge, aging, 3D)
- Silicon strips do not work
  (material budget, 3D)
- Hybrid pixels (as in LHC) do not work
  (material budget)

Fast and thin sensors: HV-MAPS



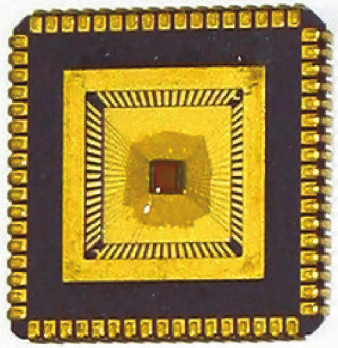
High voltage monolithic active pixel sensors

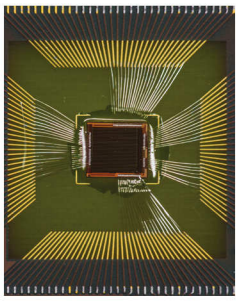
- Use a high voltage commercial process (automotive industry)
- Small active region, fast charge collection via drift
- Implement logic directly in N-well in the pixel - smart diode array
- Can be thinned down to < 50 µm
- Logic on chip: Output are zero-suppressed hit addresses and timestamps

(I.Peric, P. Fischer et al., NIM A 582 (2007) 876)

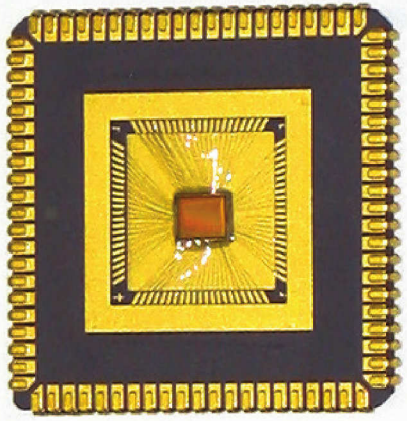
The MUPIX chip prototypes

MUPIX2

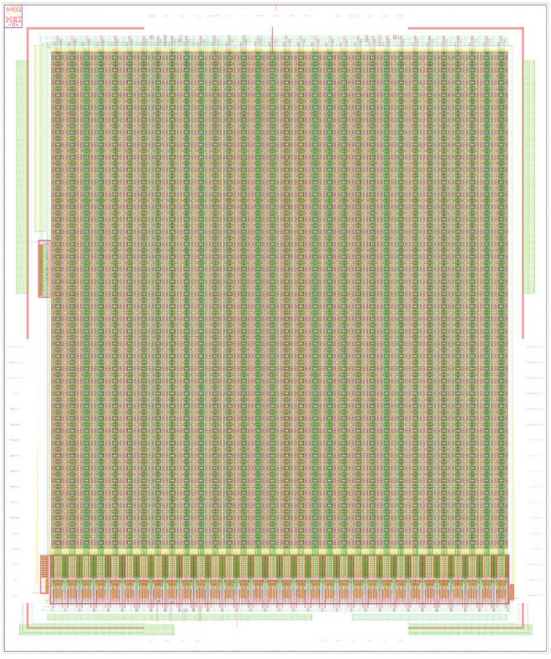




MUPIX6



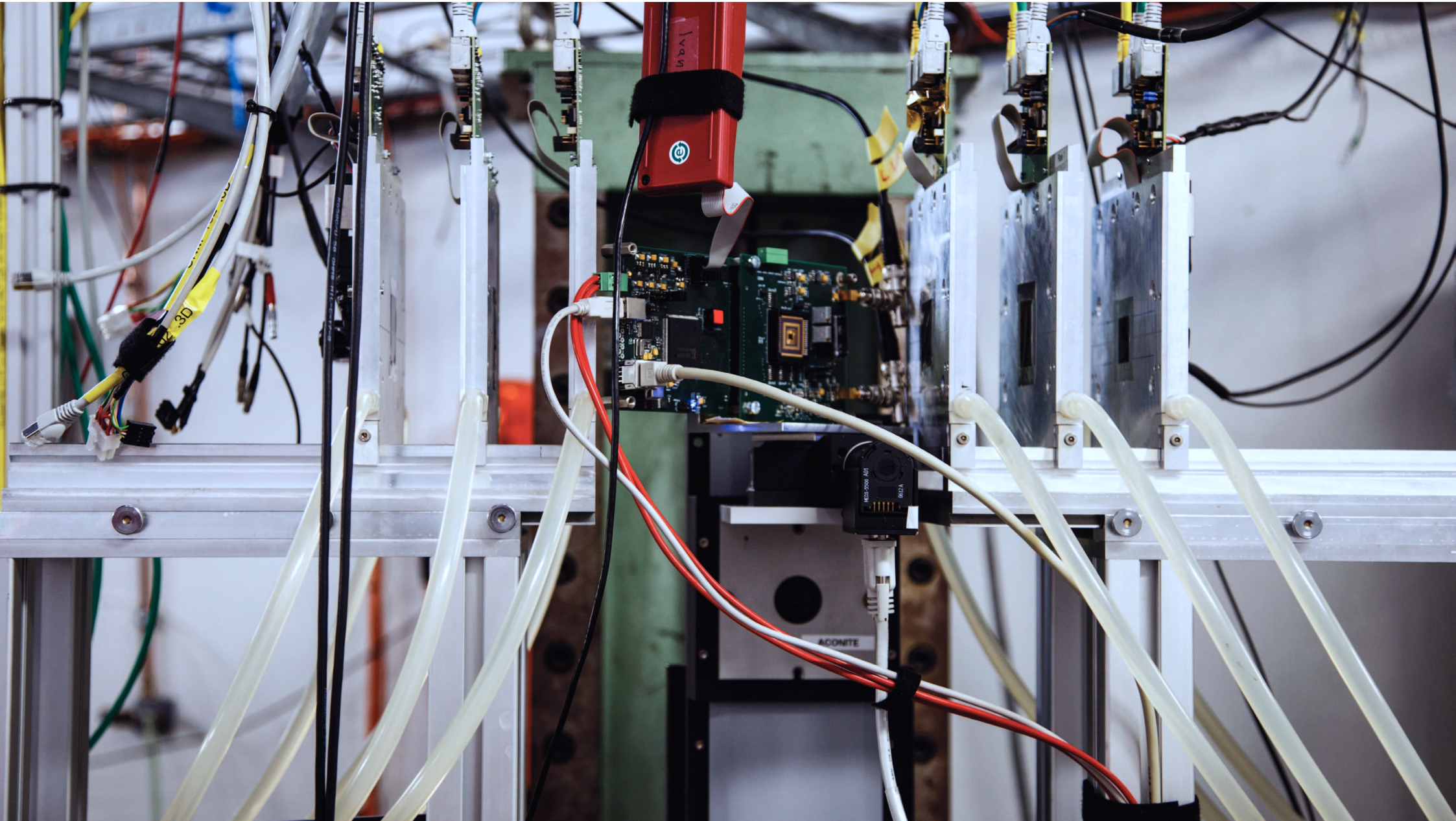
MUPIX4



HV-MAPS chips: AMS 180 nm HV-CMOS

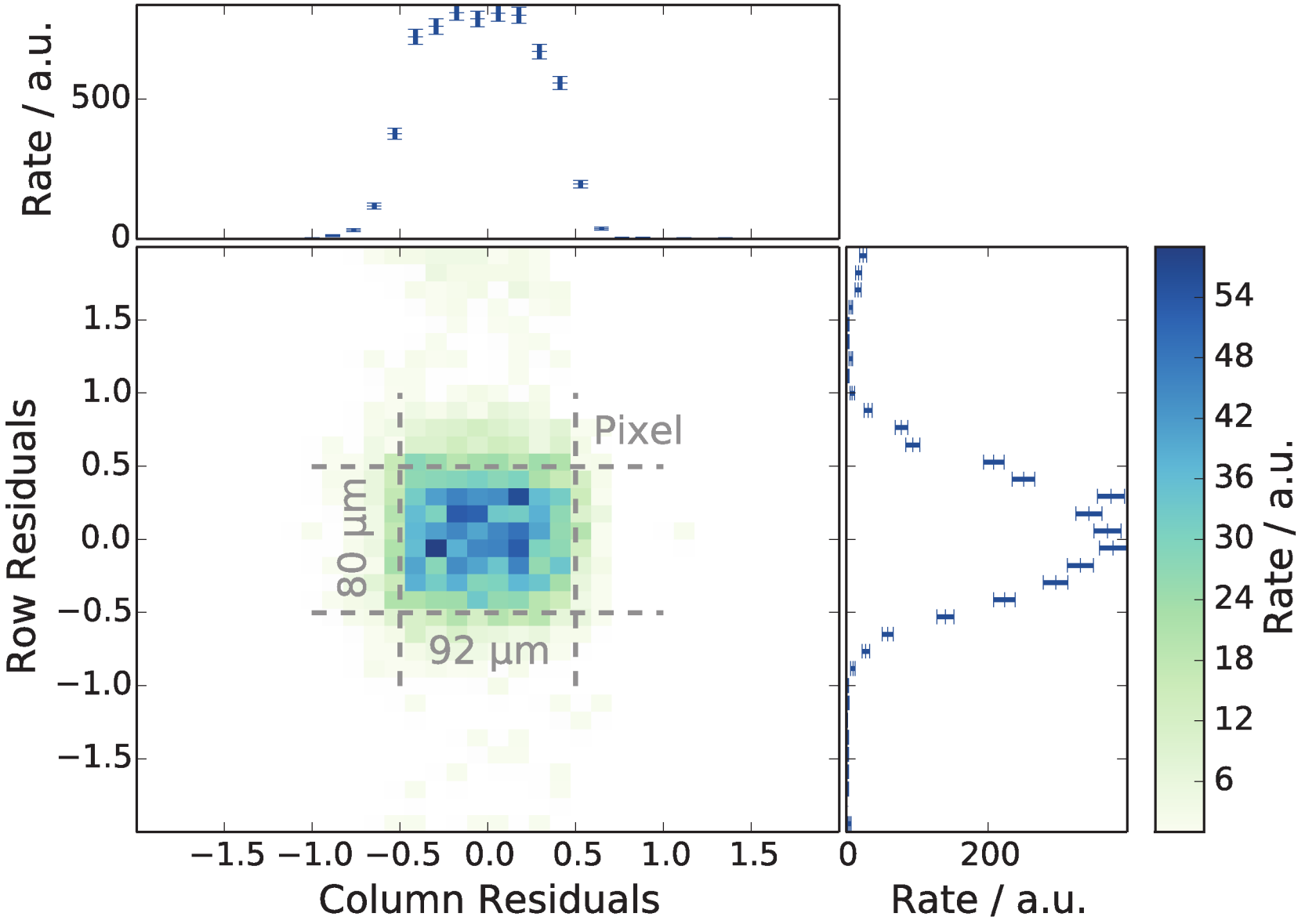
- 5 generations of prototypes
- Current generation:
  MUPIX6
  40 x 32 pixels
  80 x 103 µm pixel size
  9.4 mm^2 active area
- Test beam results with MUPIX4
- MUPIX7 (August submission) will have all features of final sensor
- Left to do: Scale to 1 x 2 and 2 x 2 cm^2

Test beam at DESY



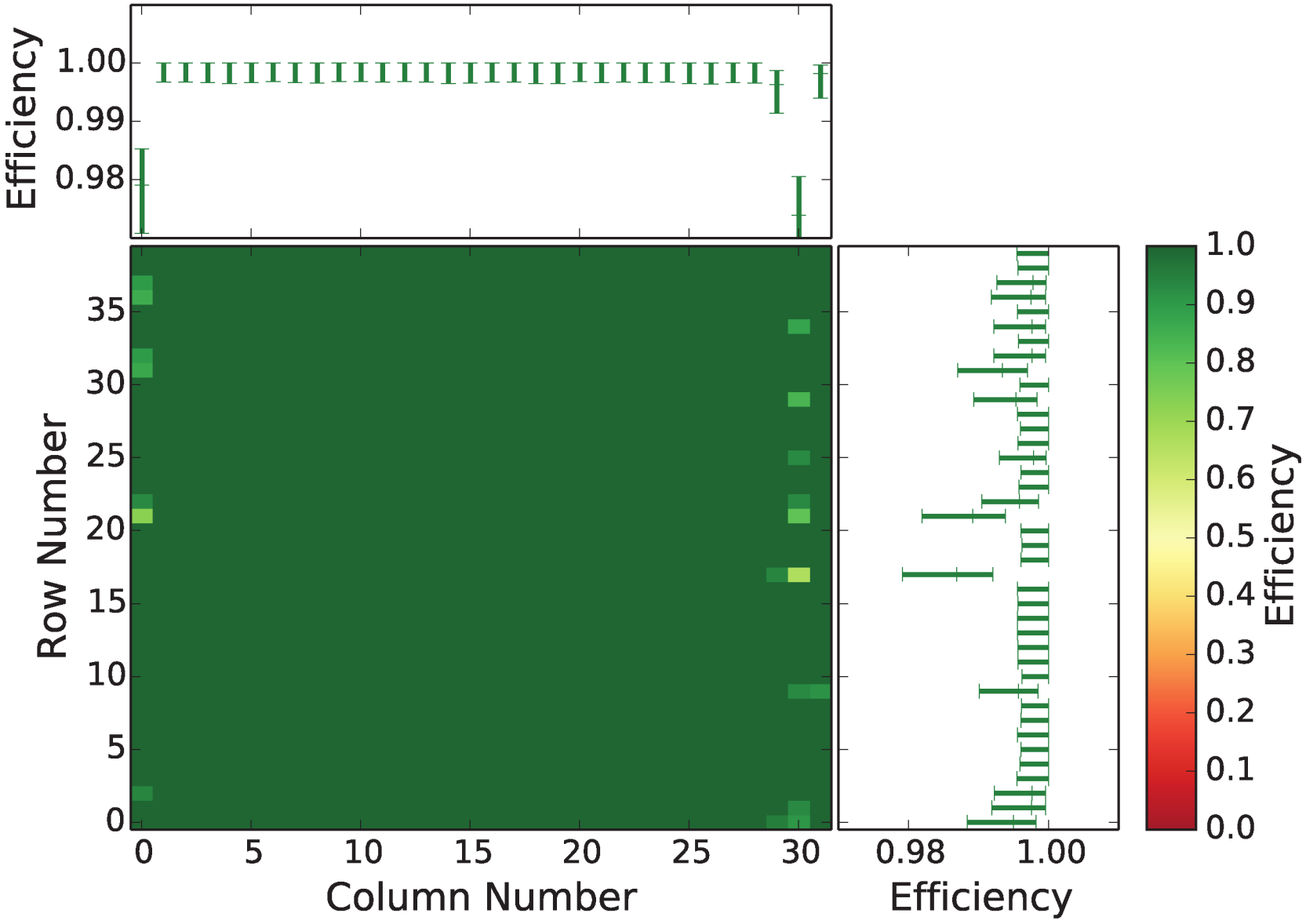
Position Resolution

Position resolution given by pixel size

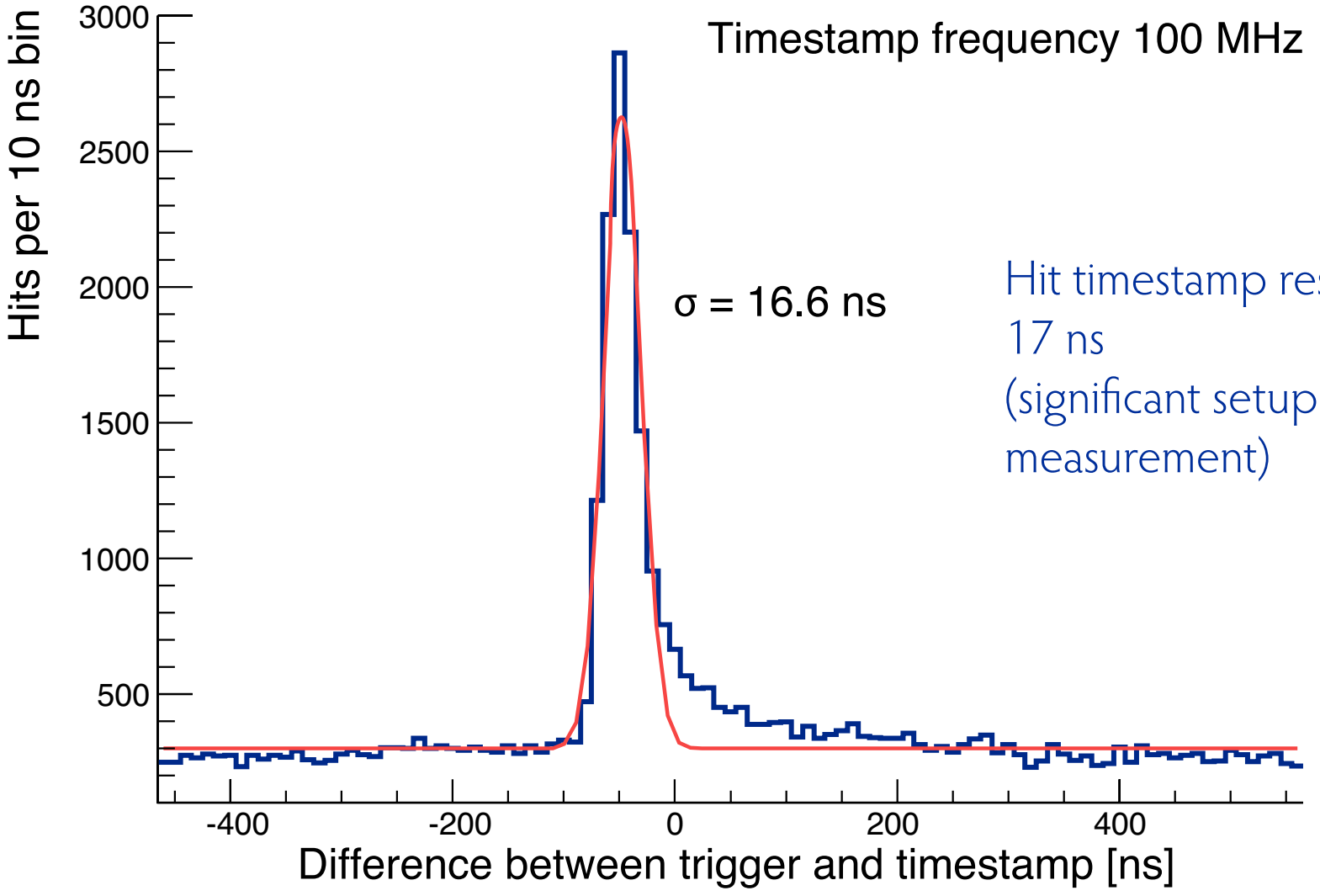


Efficiency

Hit efficiency above 99% without tuning

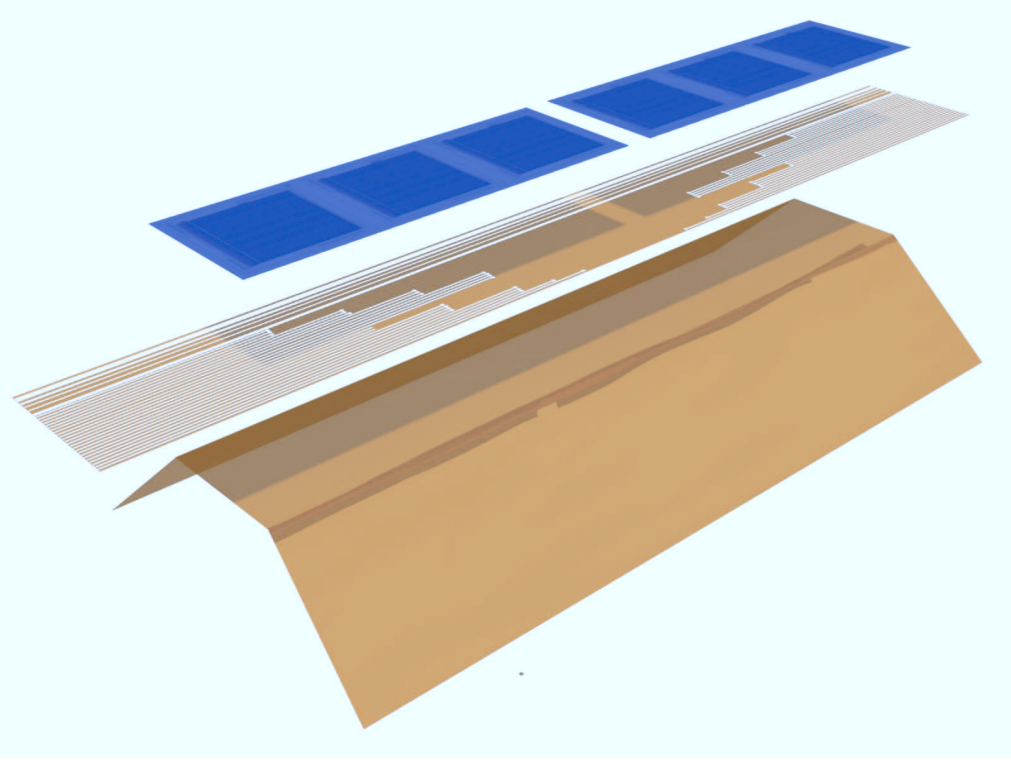


Time resolution

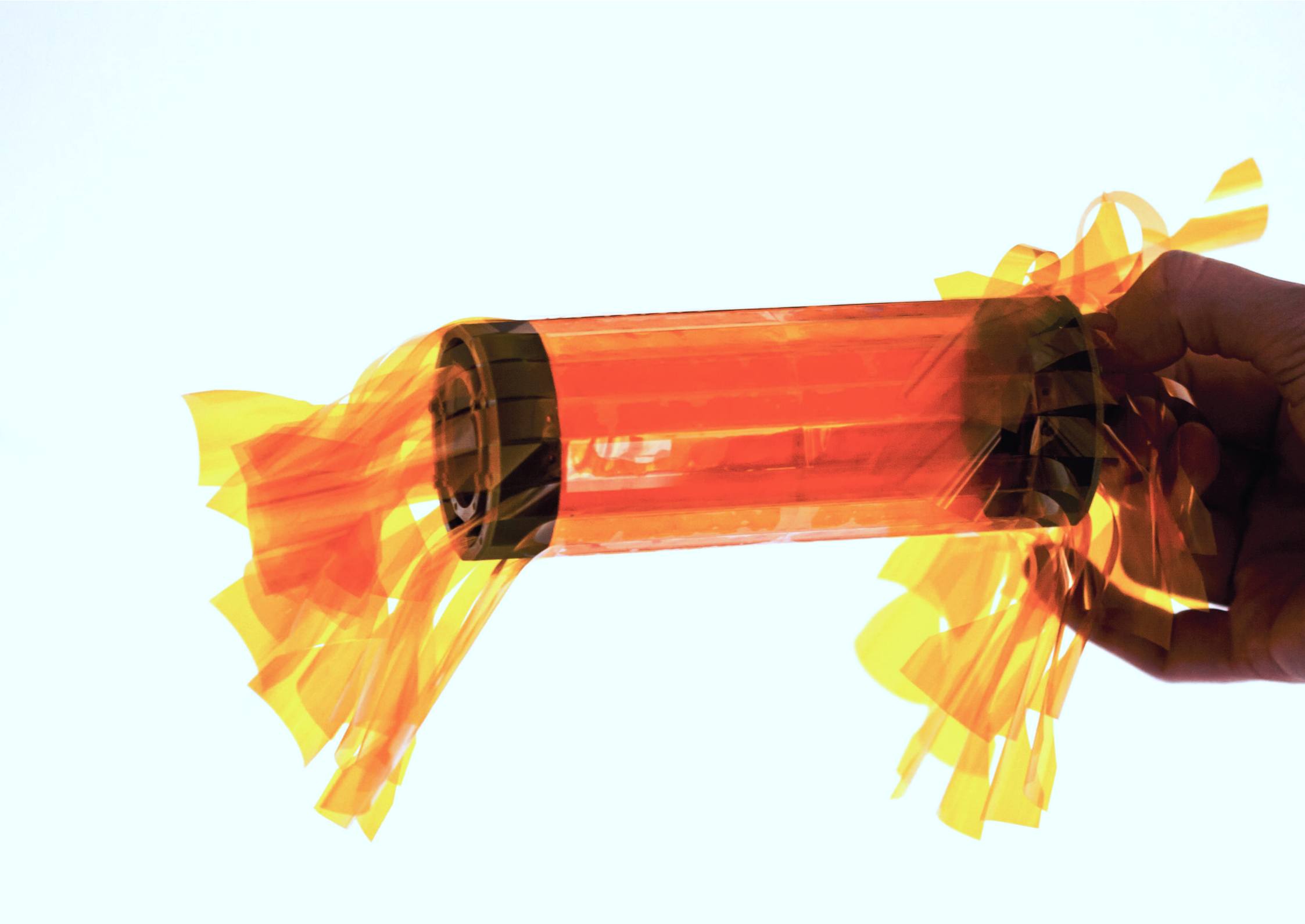


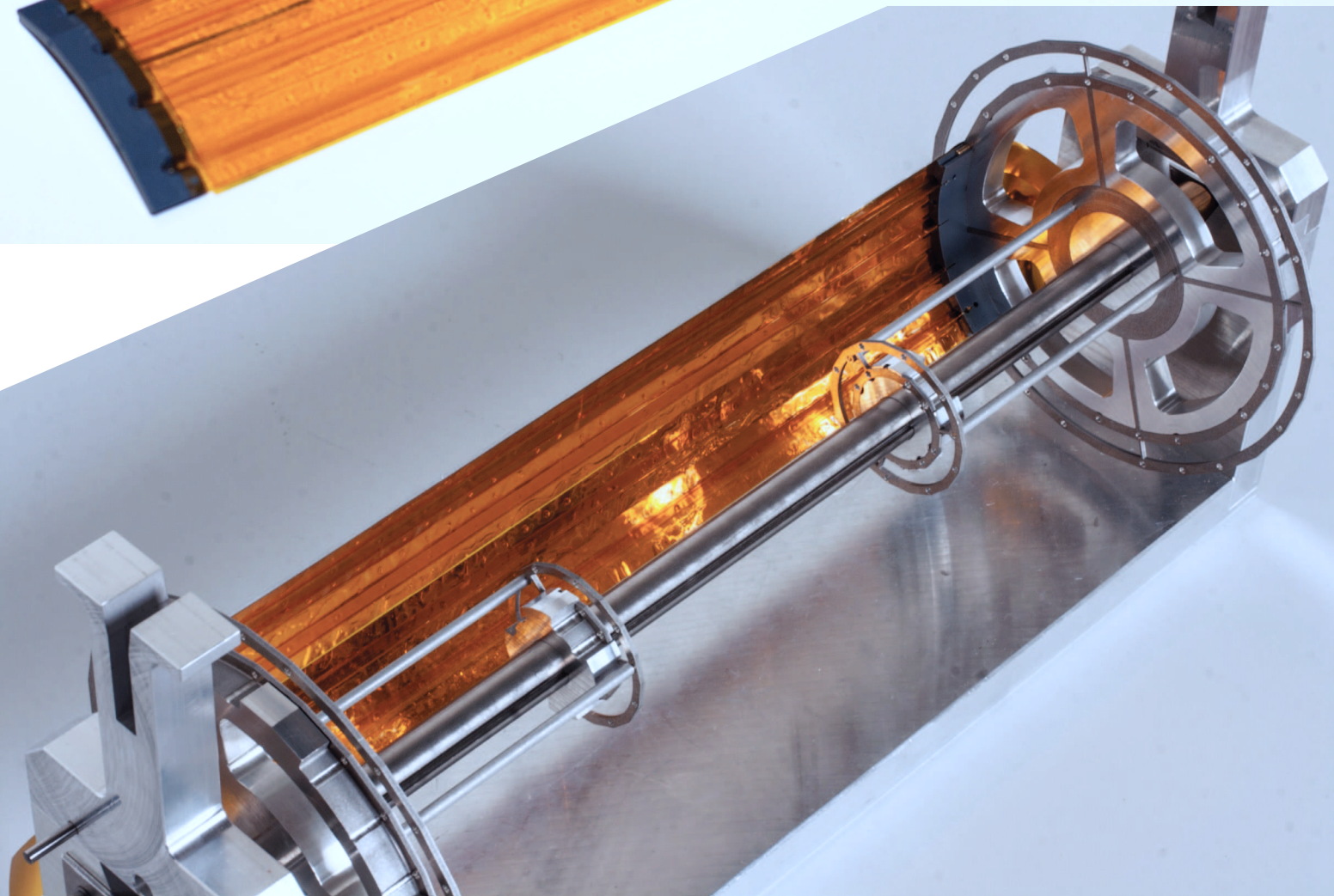
Hit timestamp resolution better than 17 ns
(significant setup contribution in the measurement)

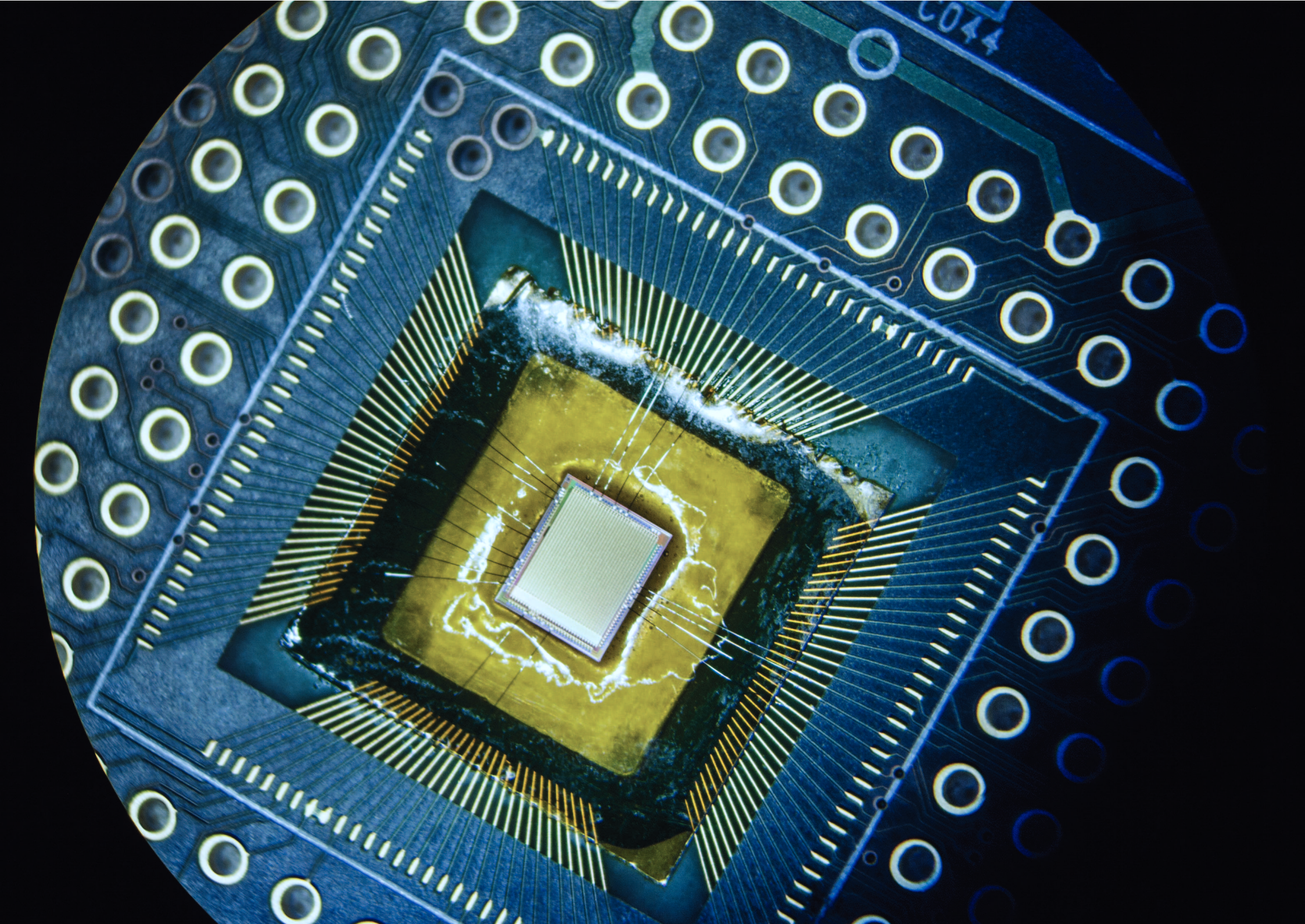
Mechanics



- 50 µm silicon
- 25 µm Kapton™ flexprint with aluminium traces
- 25 µm Kapton™ frame as support
- Less than 1‰ of a radiation length per layer



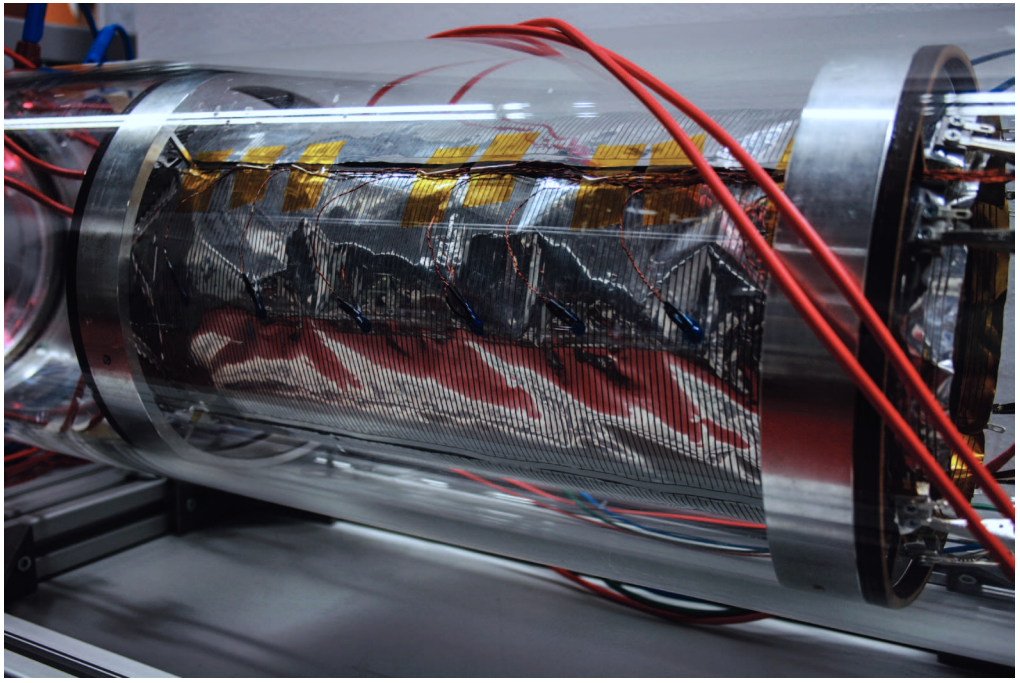


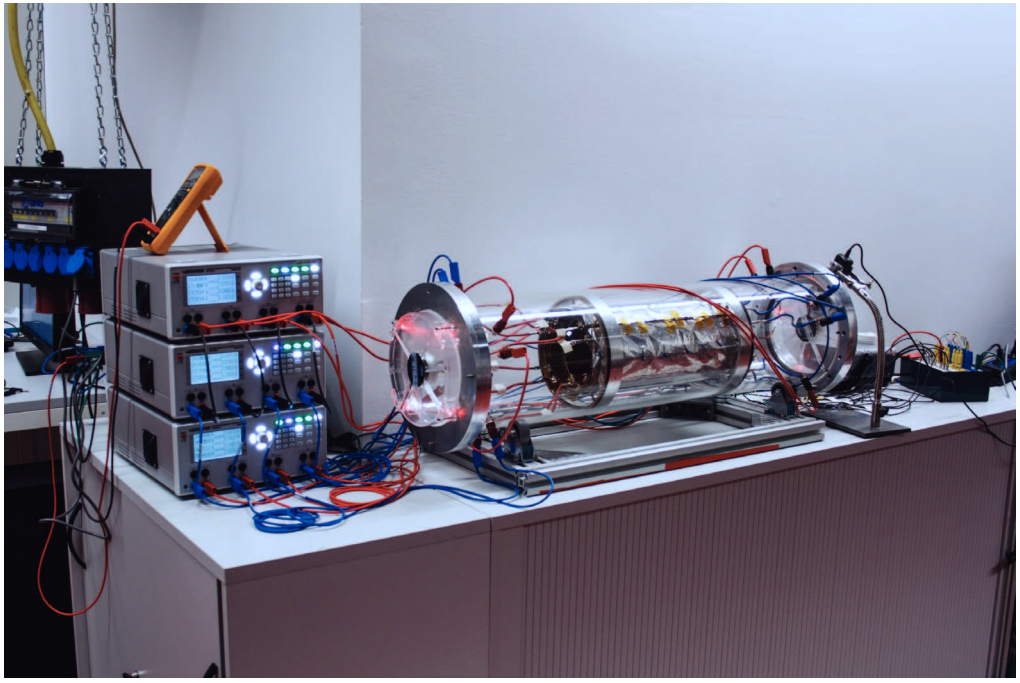

C044

Cooling

- Add no material:
  Cool with gaseous Helium
  (low scattering, high mobility)
- ~ 150 mW/cm^2 - total 2 kW
- Simulations: Need ~ several m/s flow

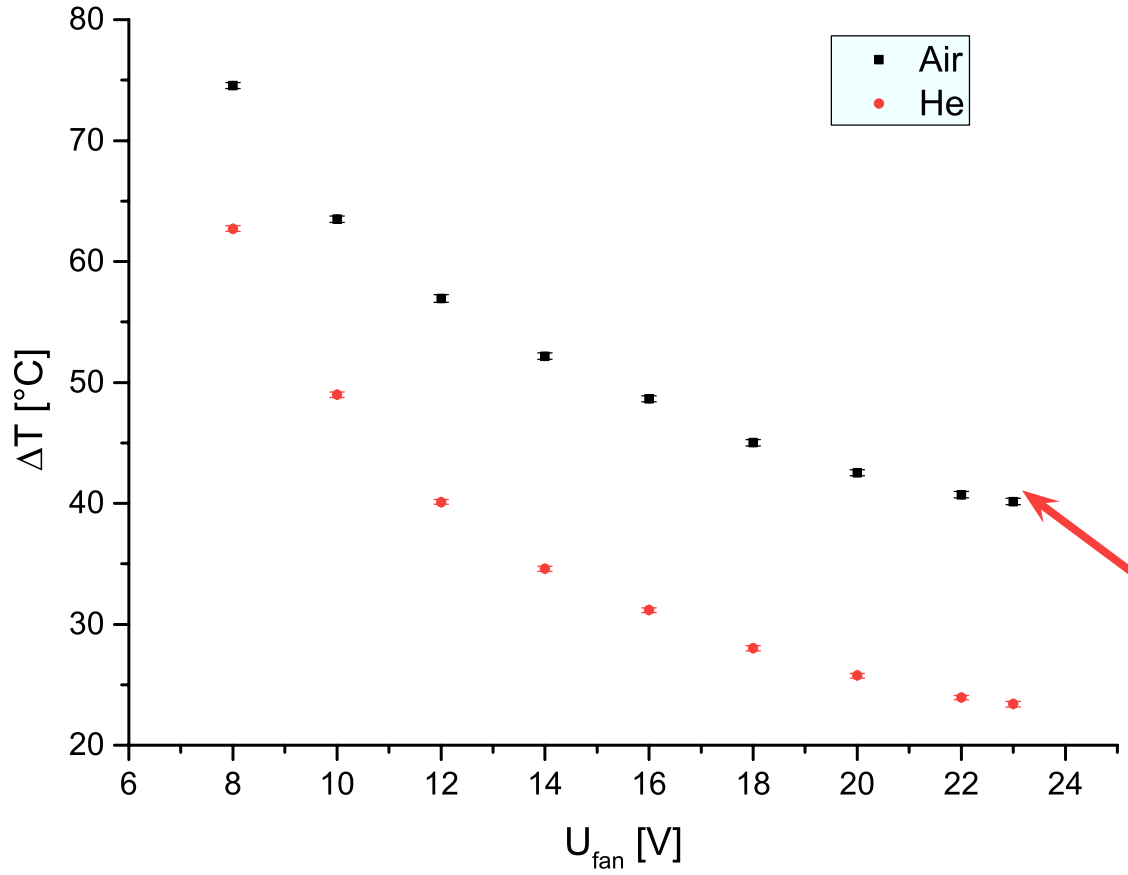
- Full scale heatable prototype built
- 36 cm active length
- No visible vibrations



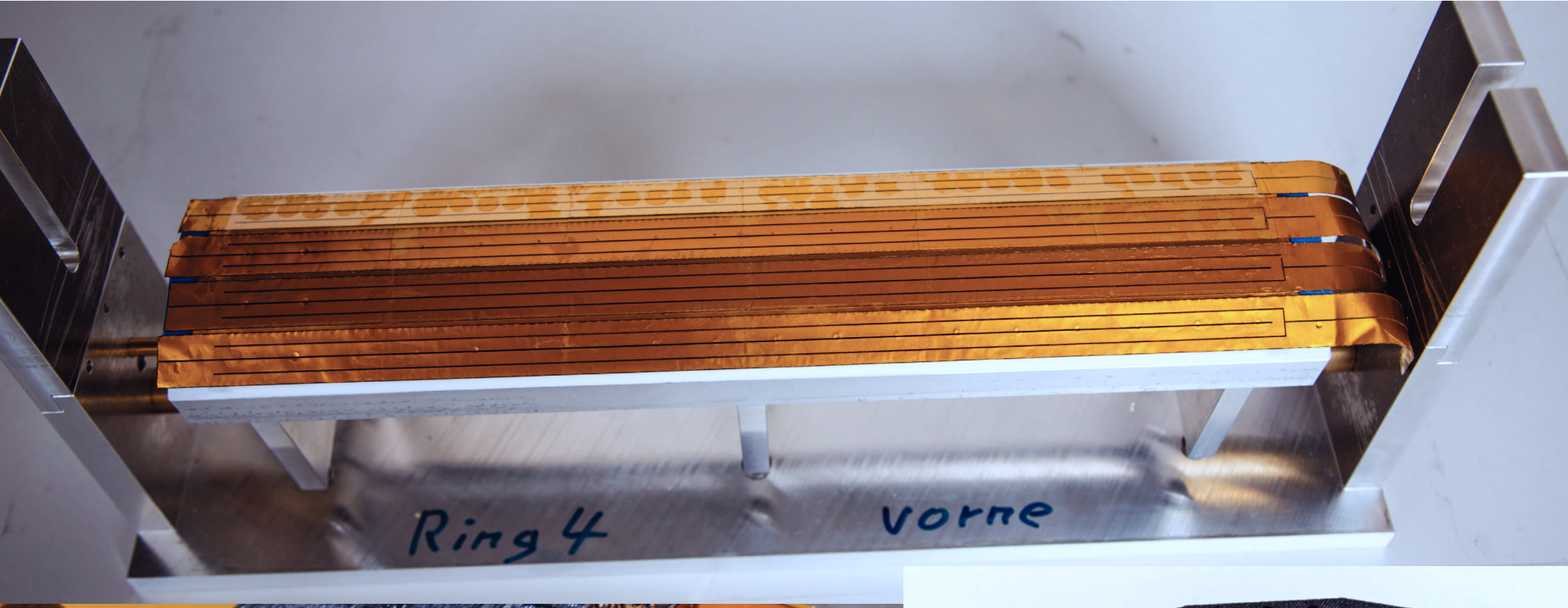


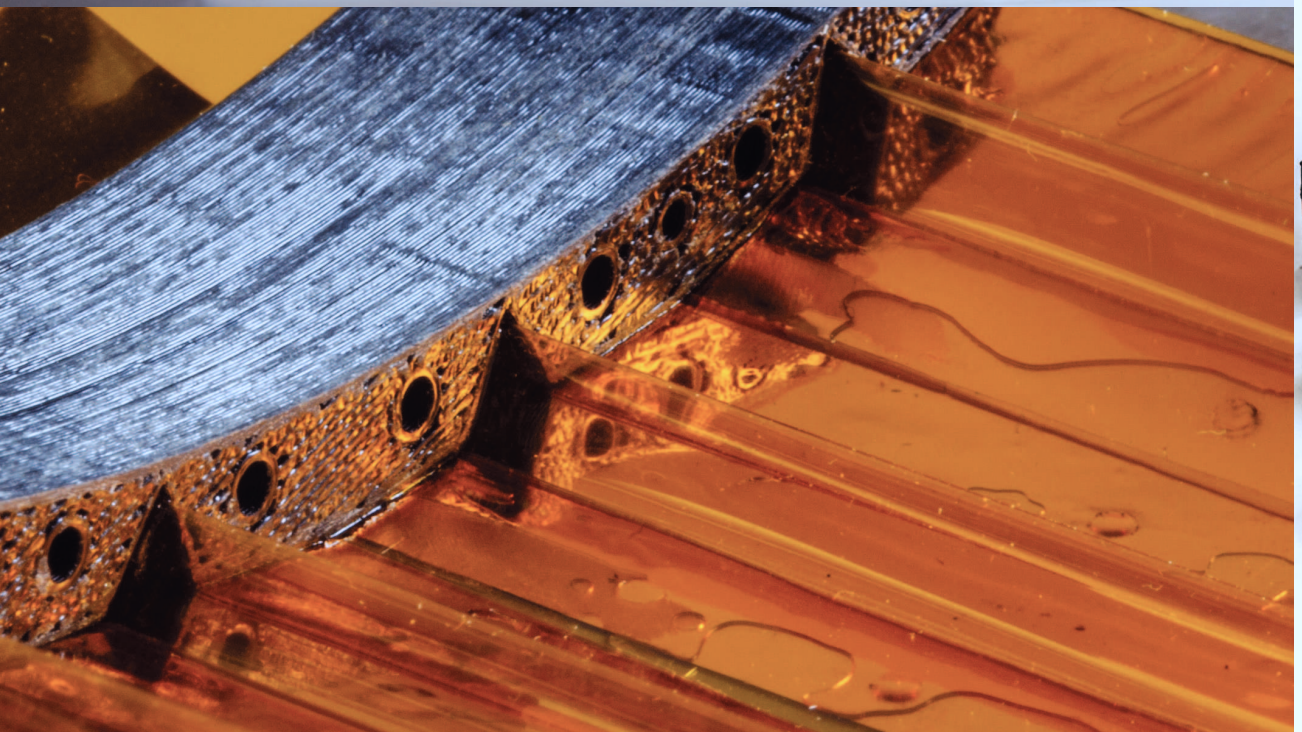
Cooling tests

- Can keep gradients under 30°C over 36 cm with helium cooling
- Helium flow speed still needs to be calibrated
- Fulfilling Mu3e specs
- Can add local cooling

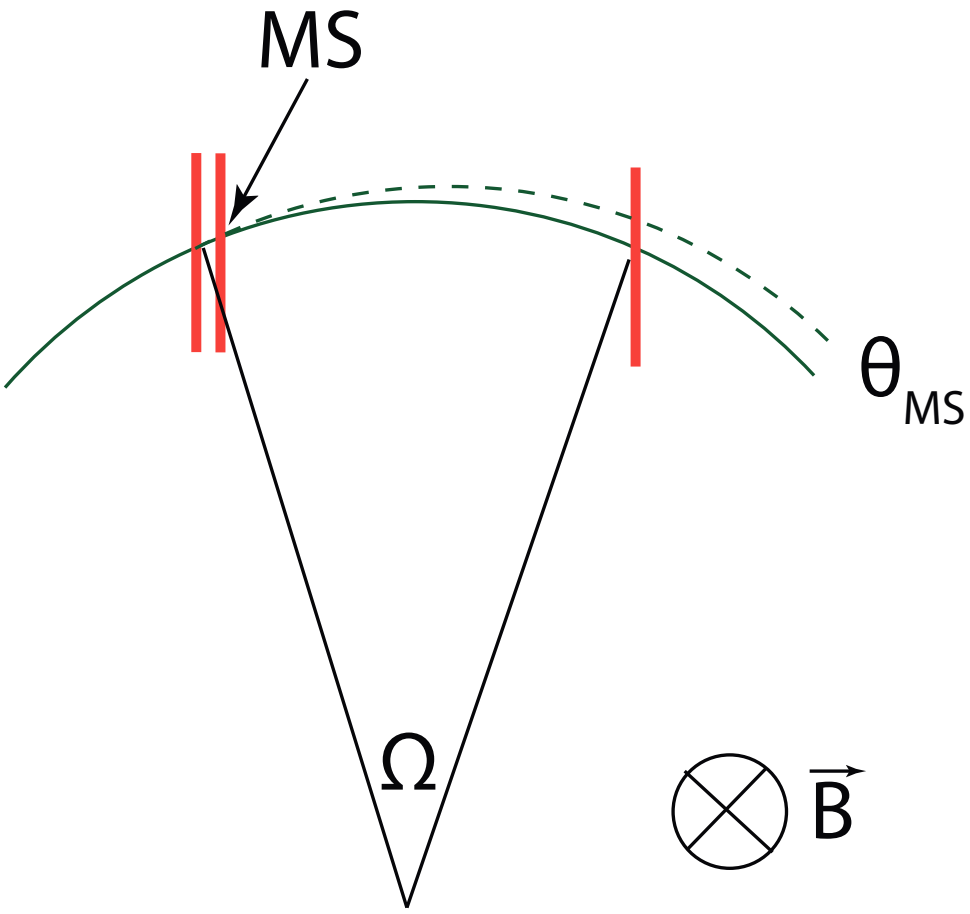


3.5 m/s in air


Ring 4
vorne



Momentum measurement

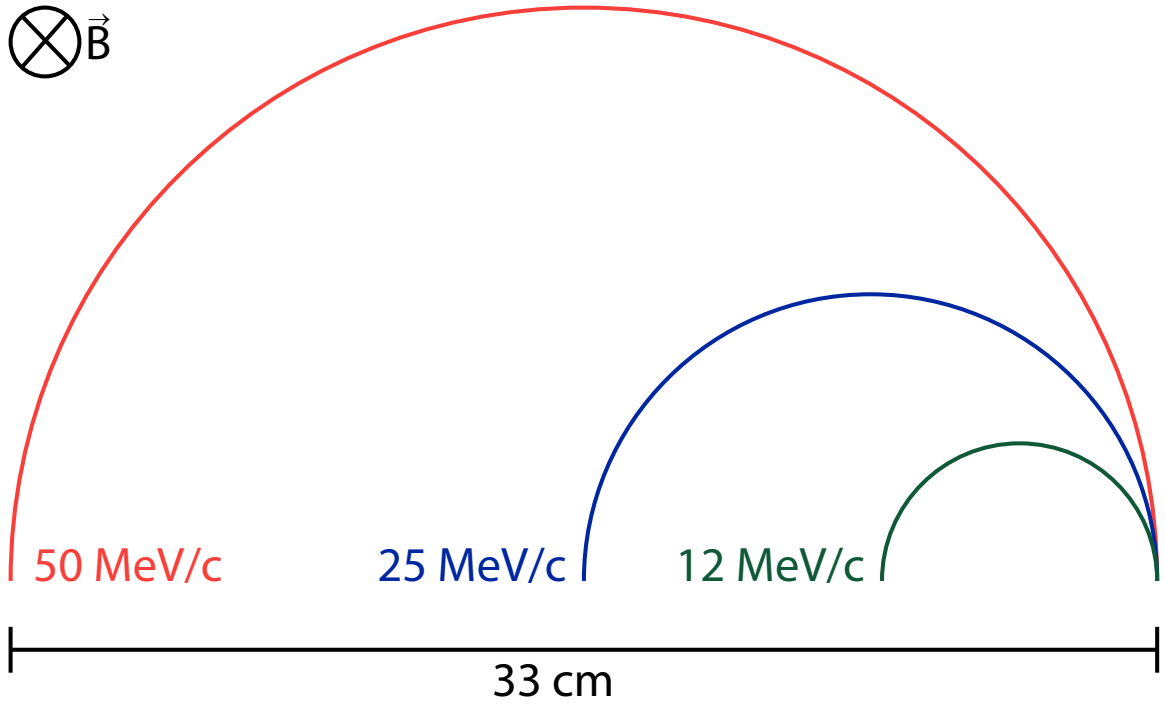


- 1 T magnetic field
- Resolution dominated by multiple scattering
- Momentum resolution to first order:

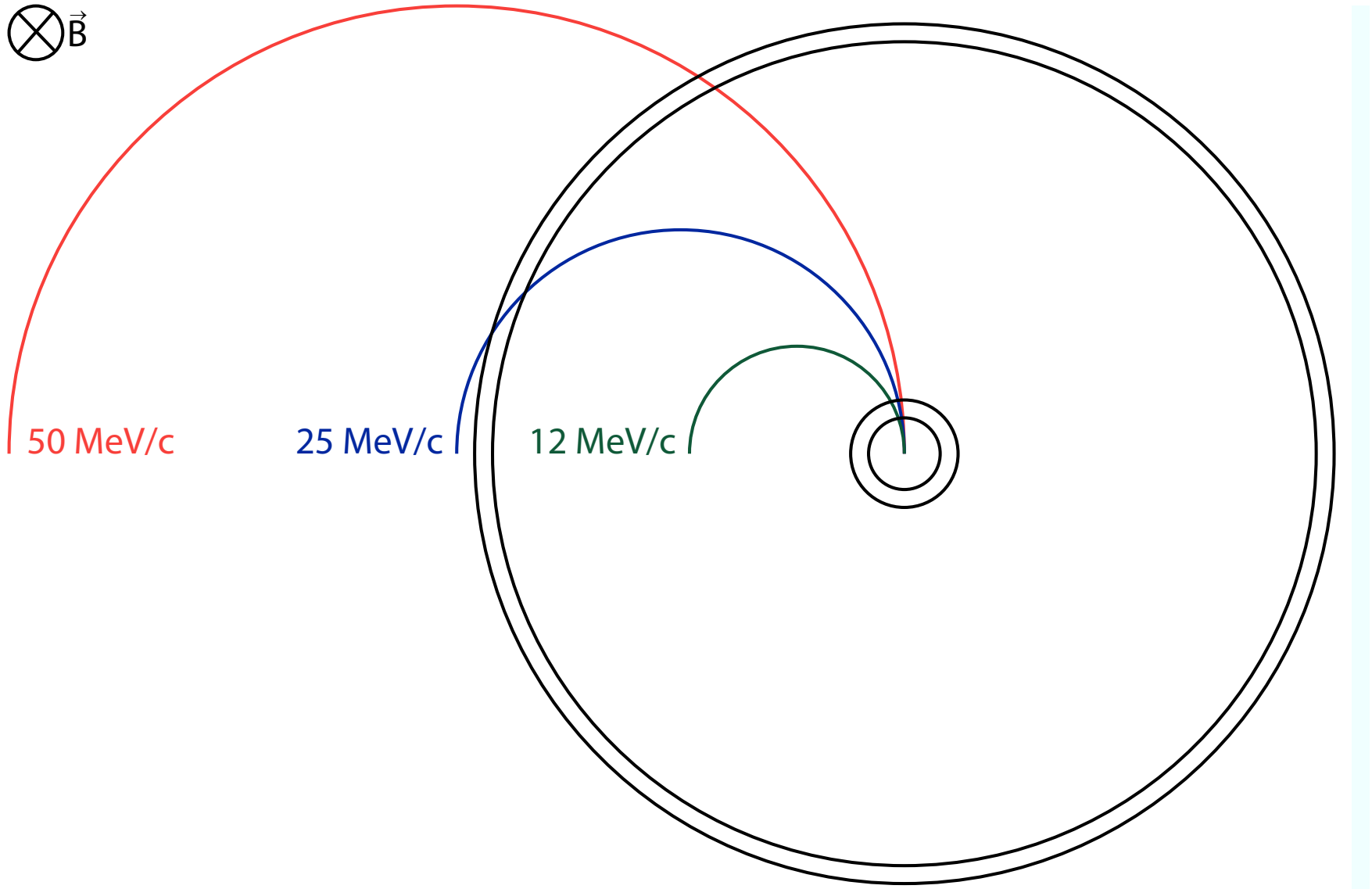
$$\sigma_P/P \sim \theta_{MS}/\Omega$$

- Precision requires large lever arm (large bending angle Ω) and low multiple scattering θ_{MS}

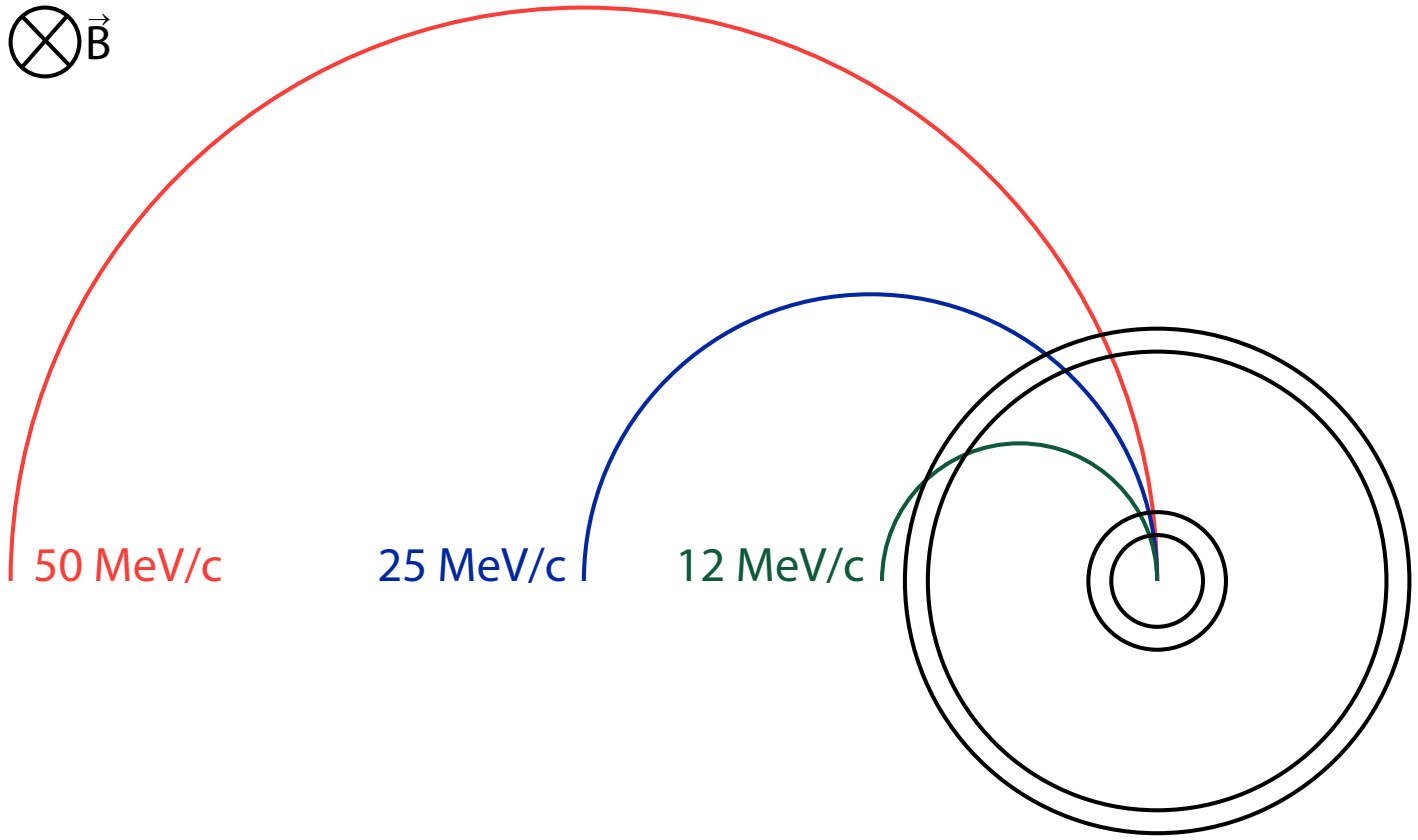
Precision vs. Acceptance



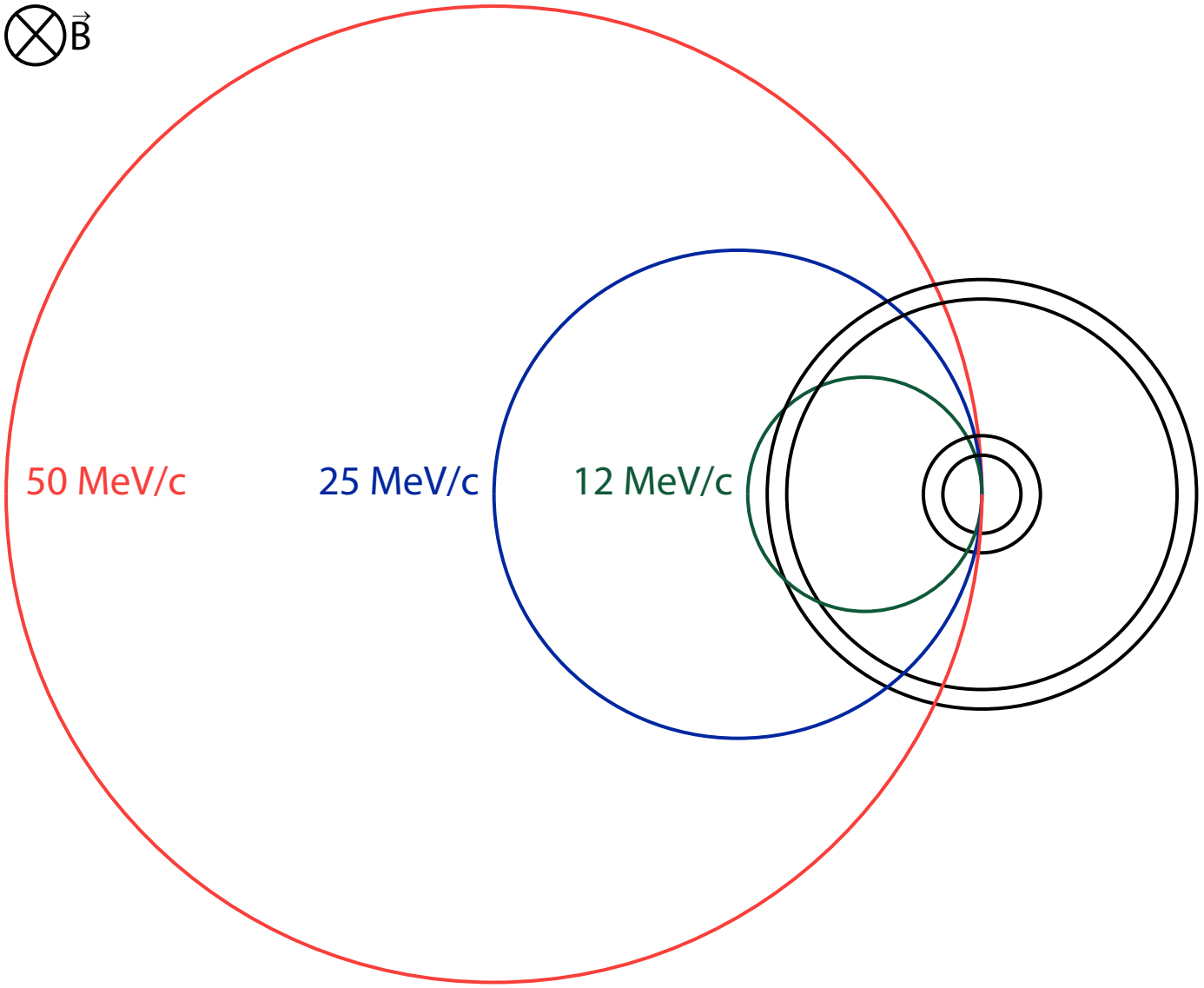
Precision vs. Acceptance



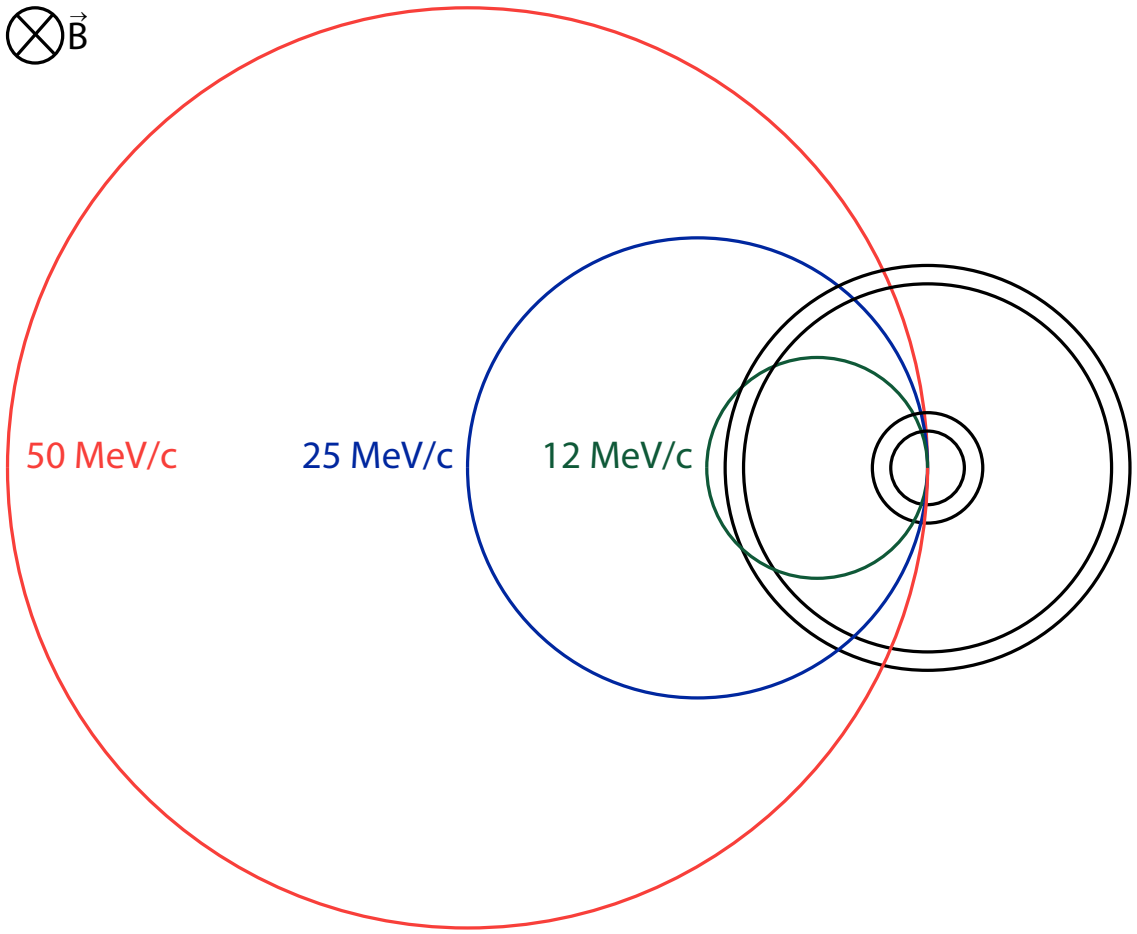
Precision vs. Acceptance

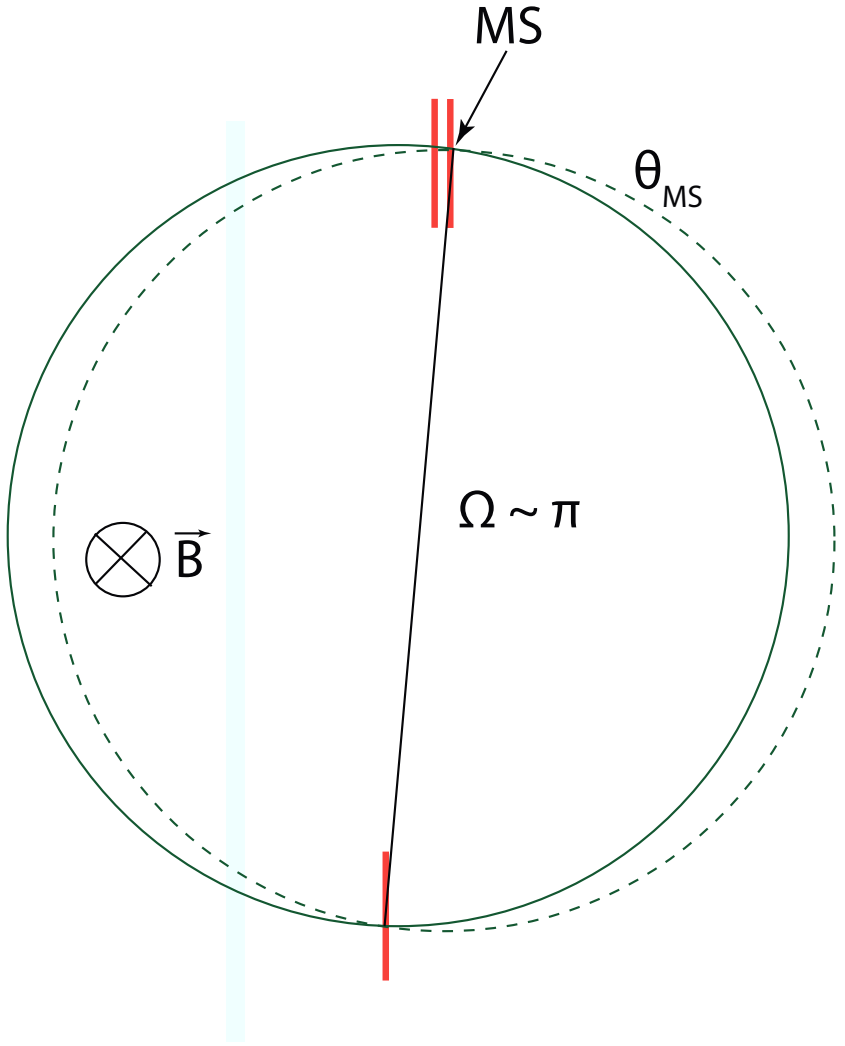


Precision vs. Acceptance

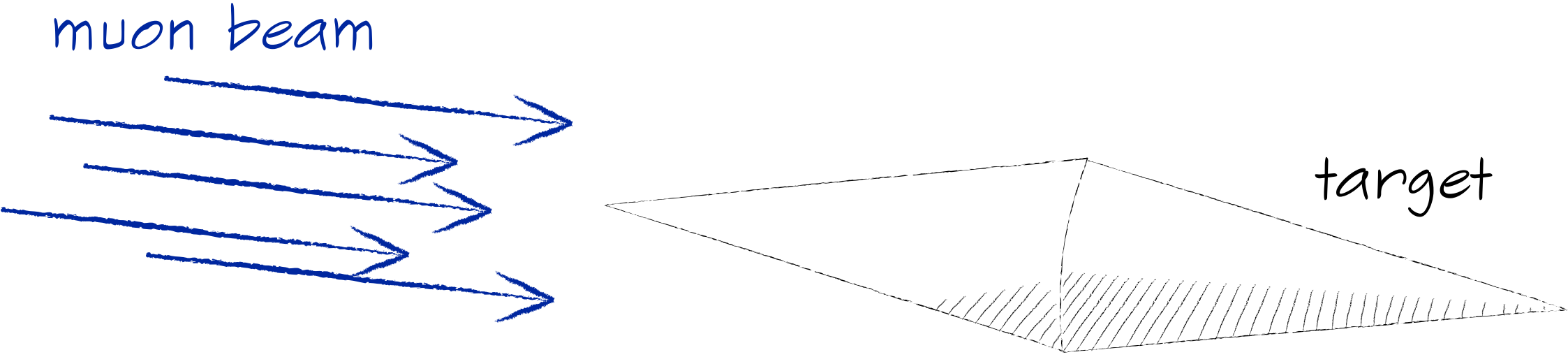


Precision vs. Acceptance

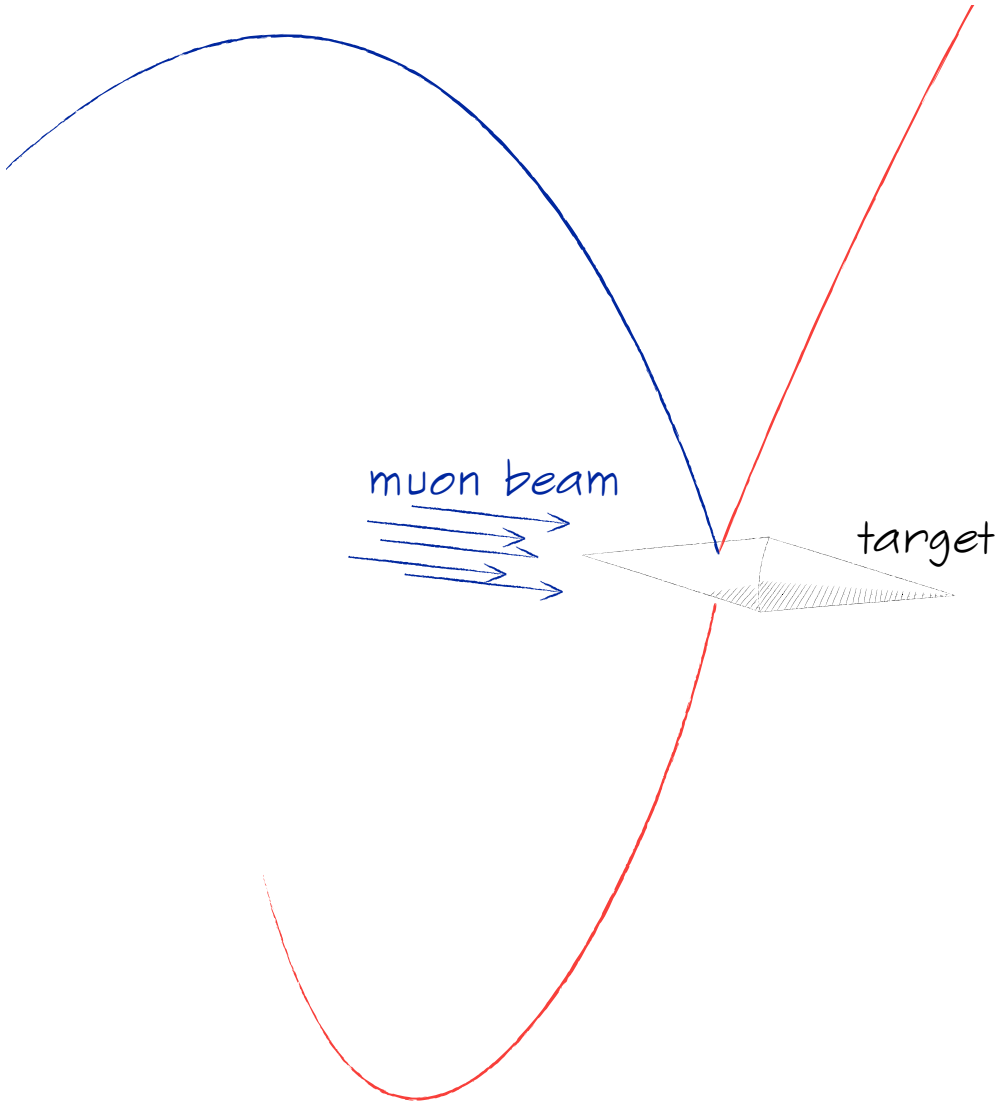




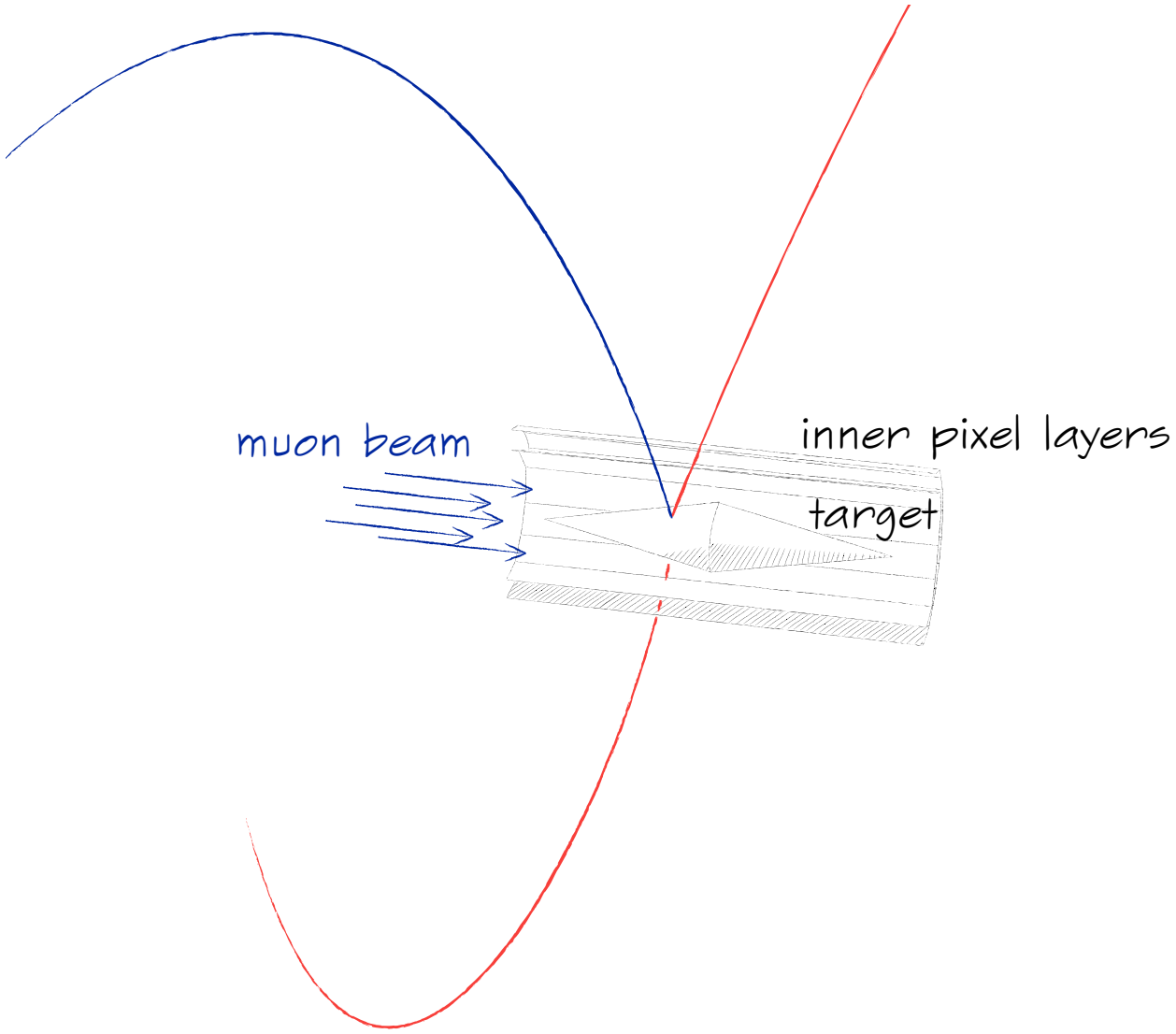
Detector Design



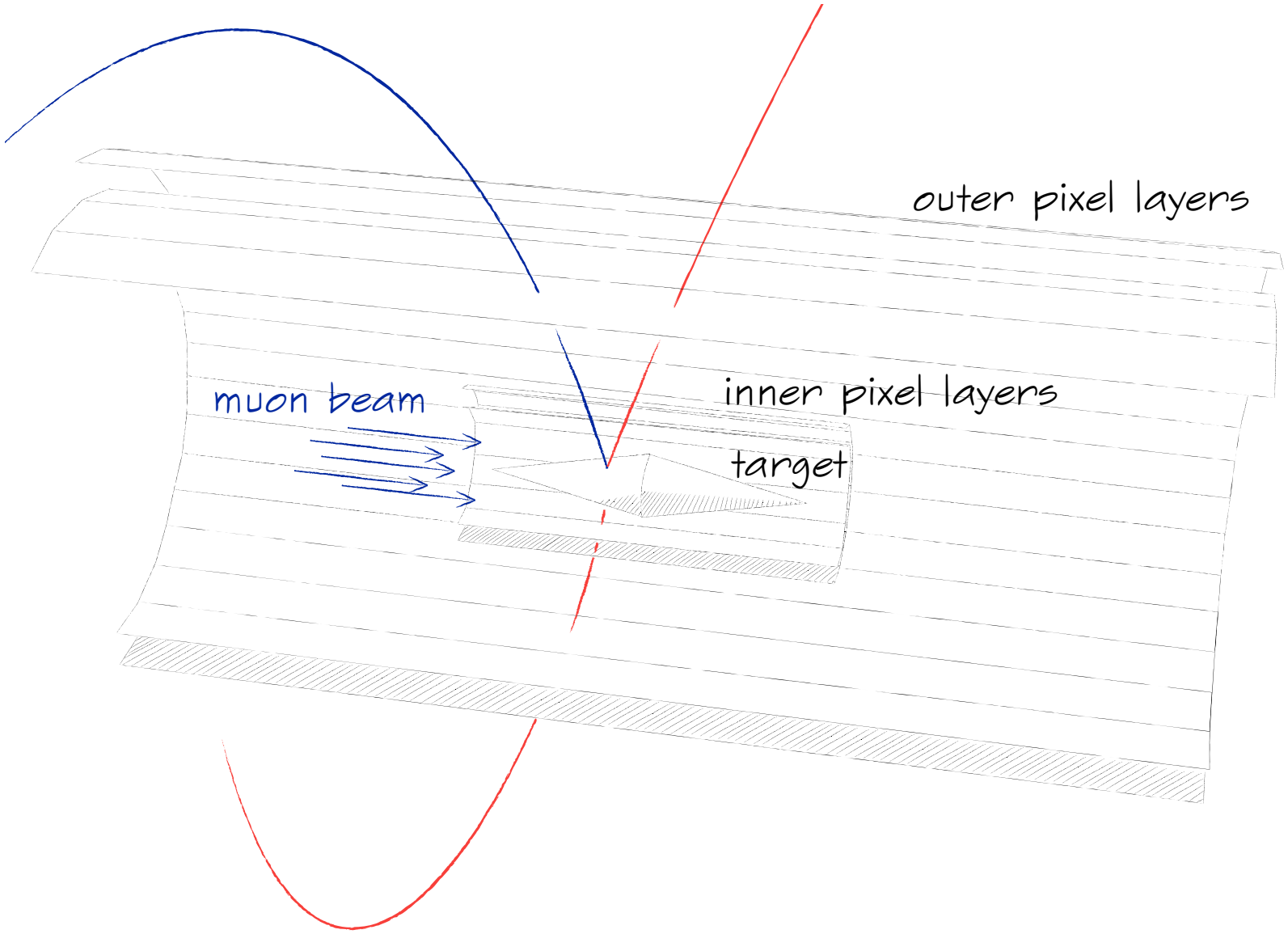
Detector Design



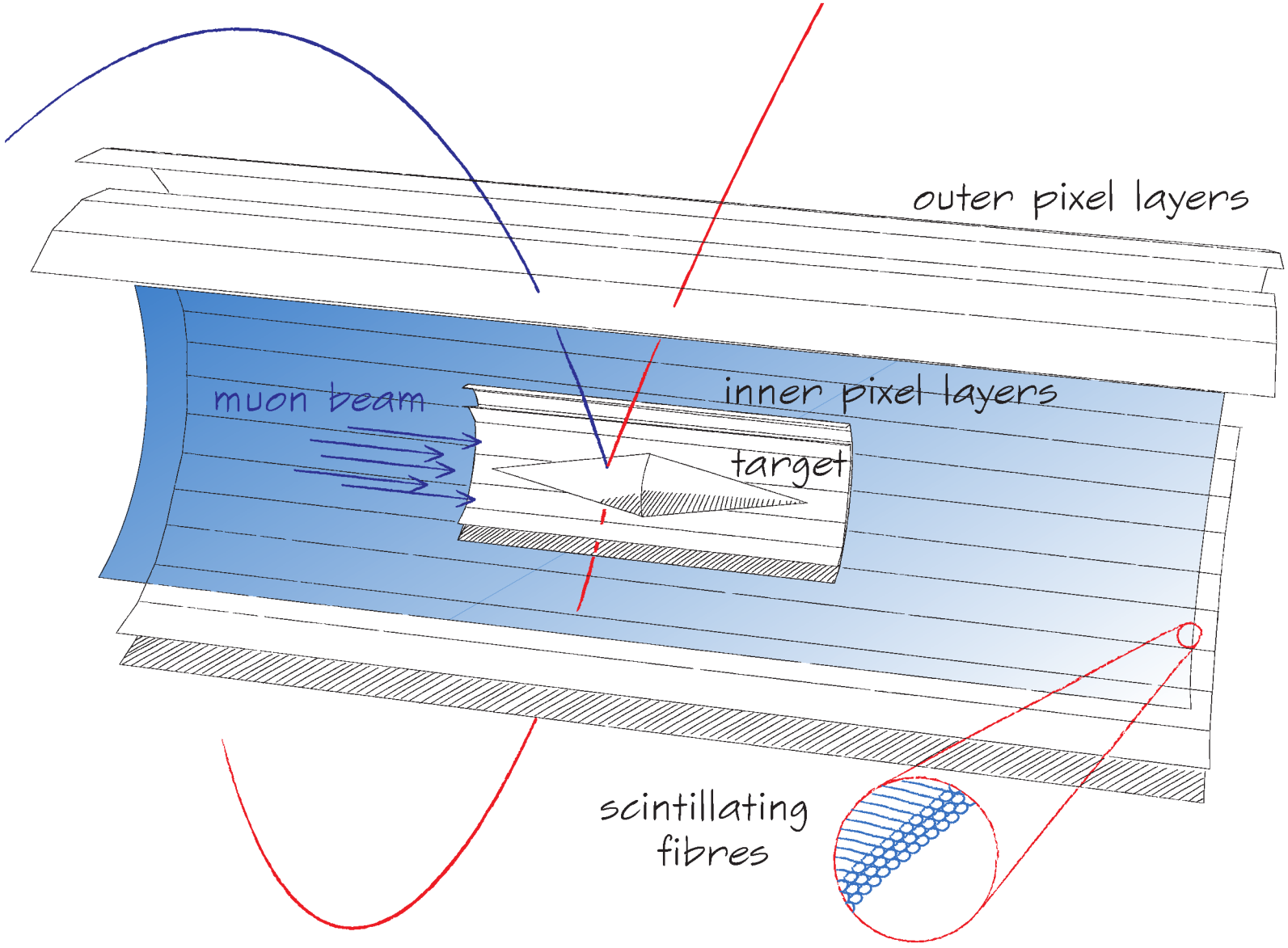
Detector Design



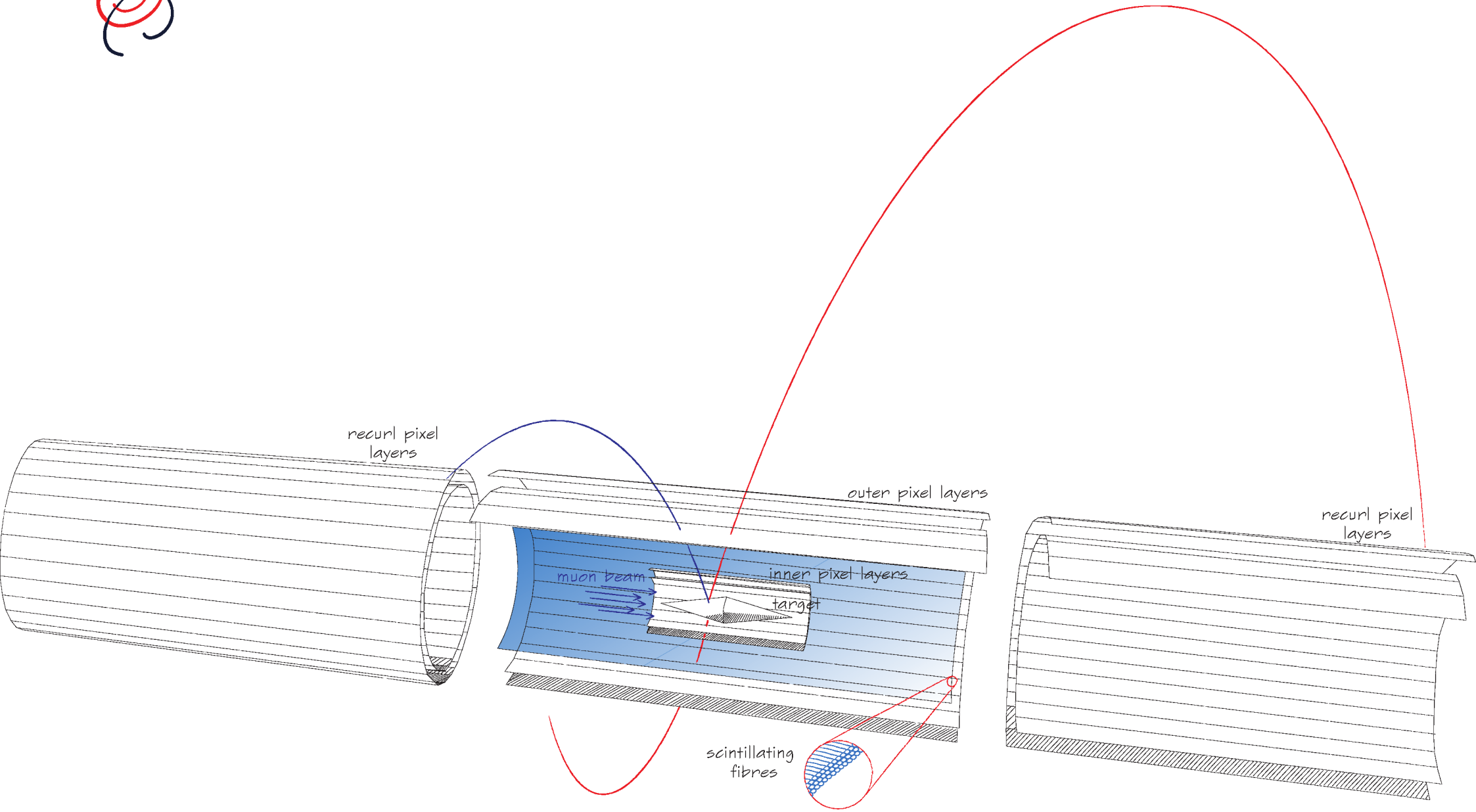
Detector Design



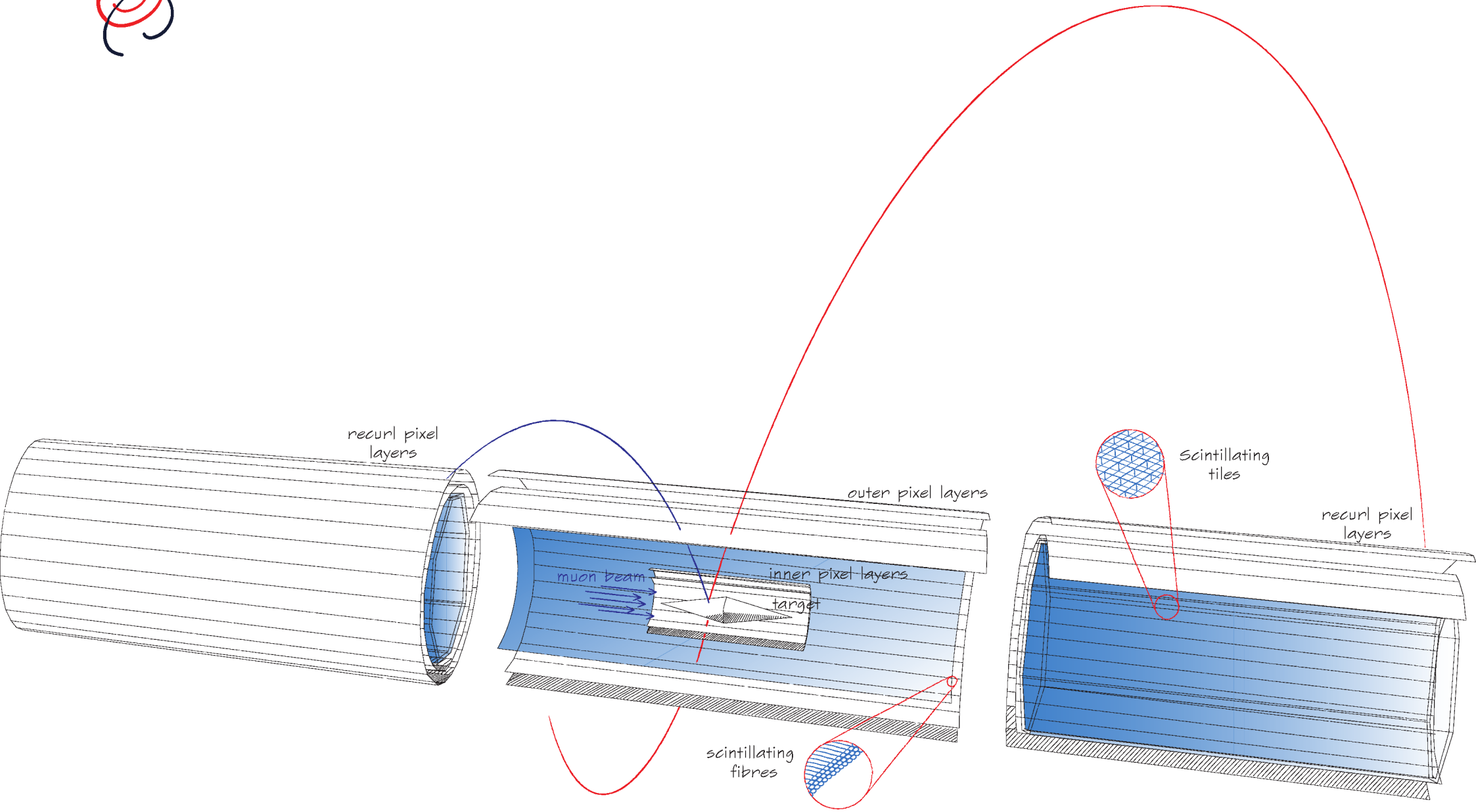
Detector Design



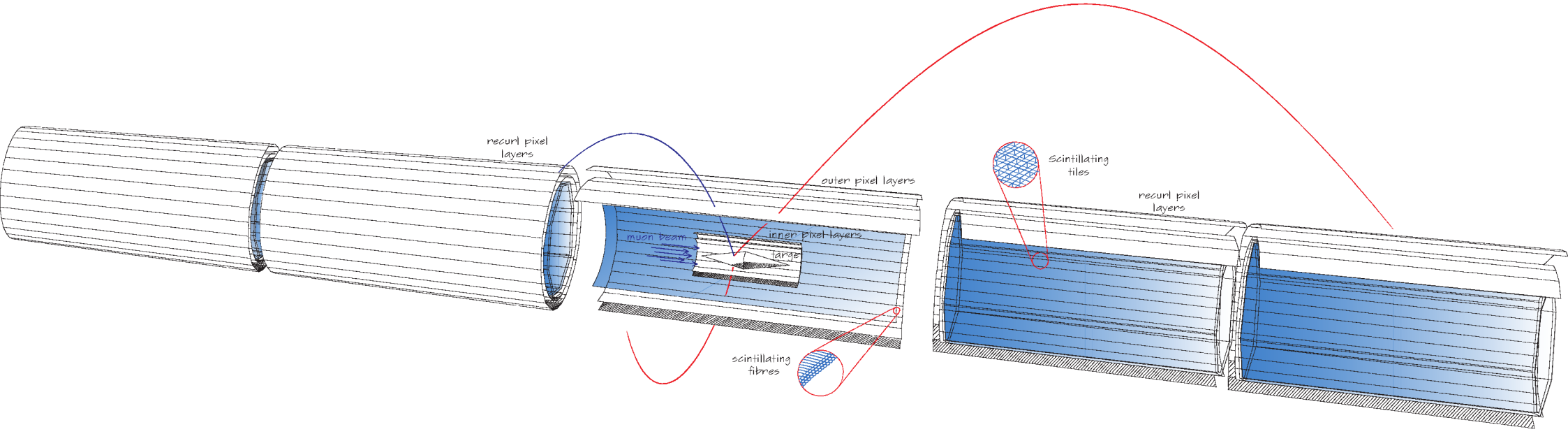
Detector Design



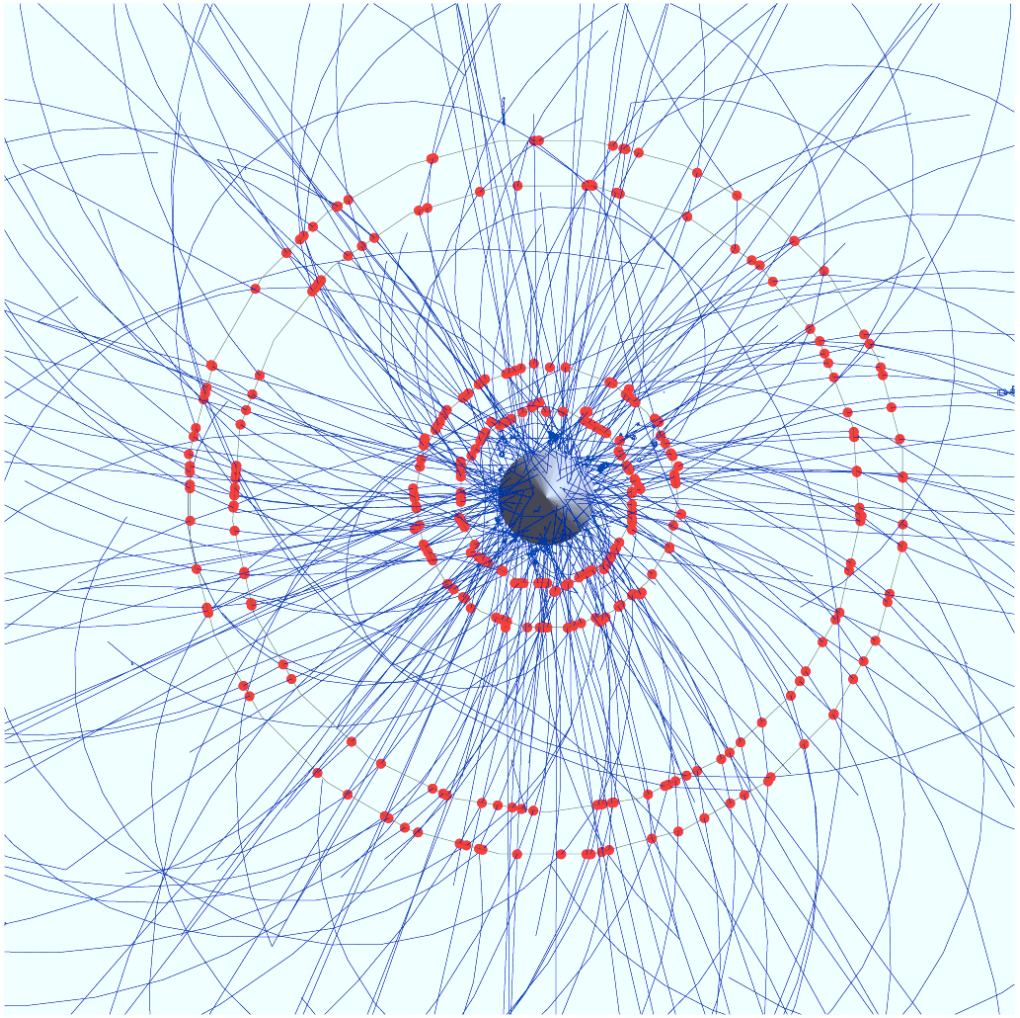
Detector Design



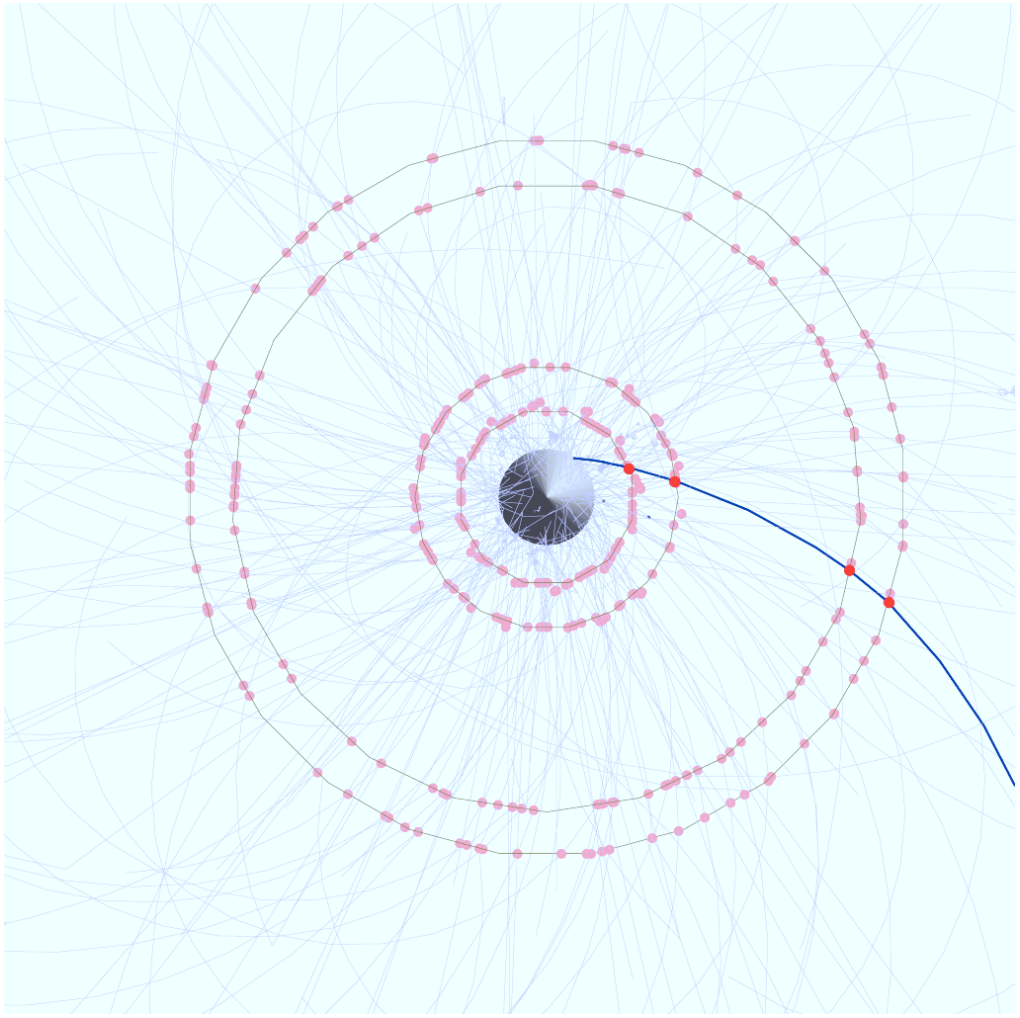
Detector Design



Timing measurements

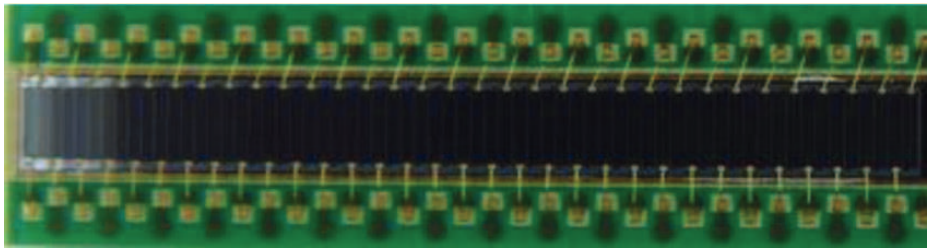


Pixels: O(50 ns)

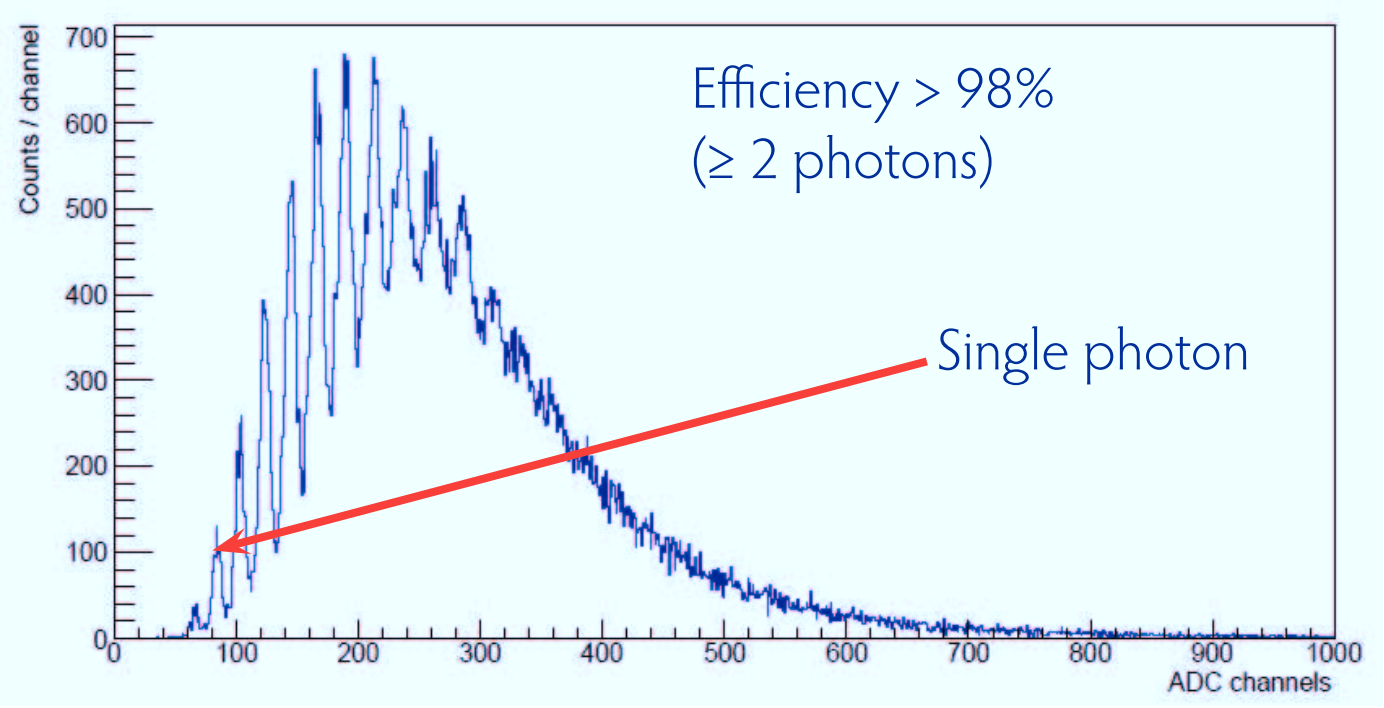


Scintillating fibres O(1 ns);
Scintillating tiles O(100 ps)

Timing Detector: Scintillating Fibres

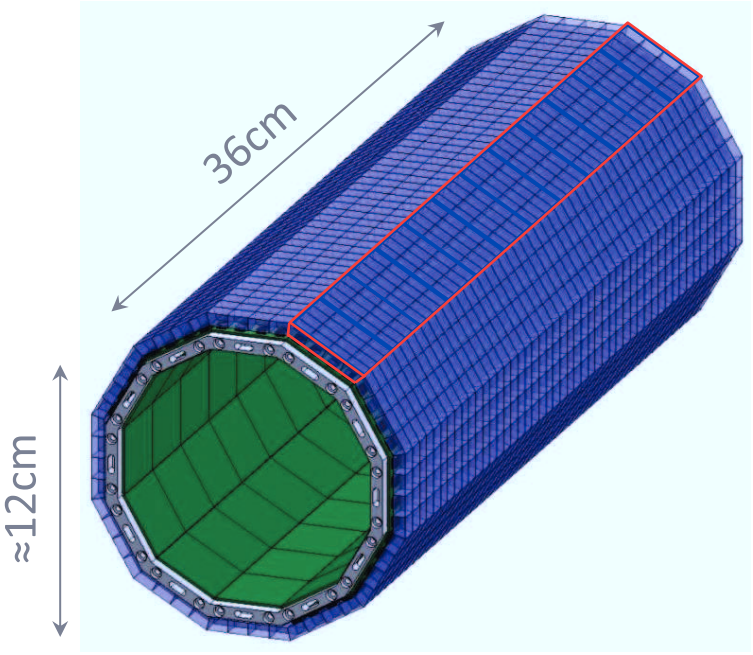


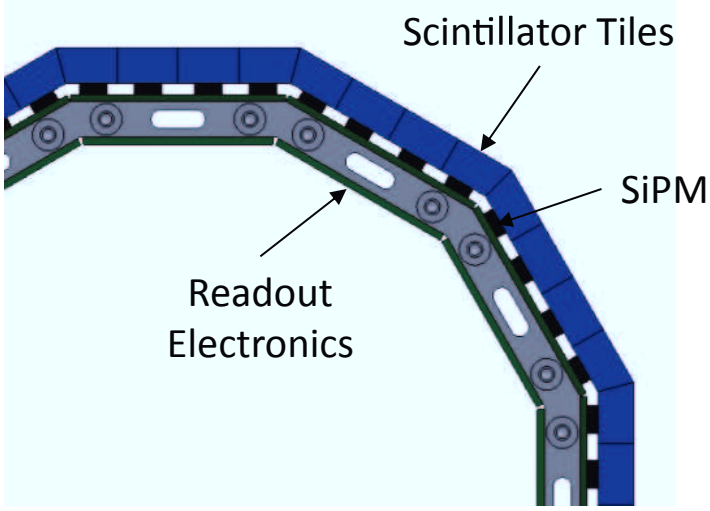
- 3-5 layers of 250 μm scintillating fibres
- Read-out by silicon photomultipliers (SiPMs) and custom ASIC (STiC)
- Timing resolution $O(1\ \text{ns})$ (measured with sodium source)



Timing Detector: Scintillating tiles

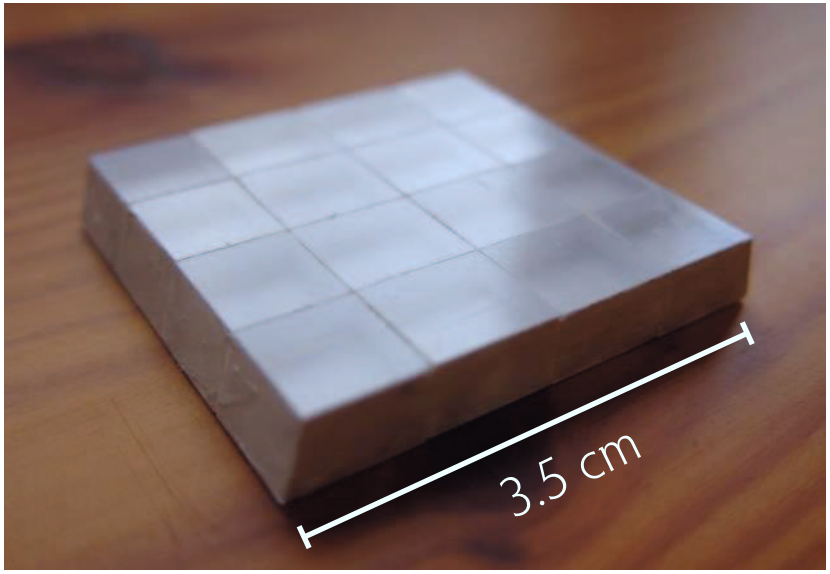
- ~ 0.5 cm^3 scintillating tiles
- Read-out by silicon photomultipliers (SiPMs) and custom ASIC (STiC)



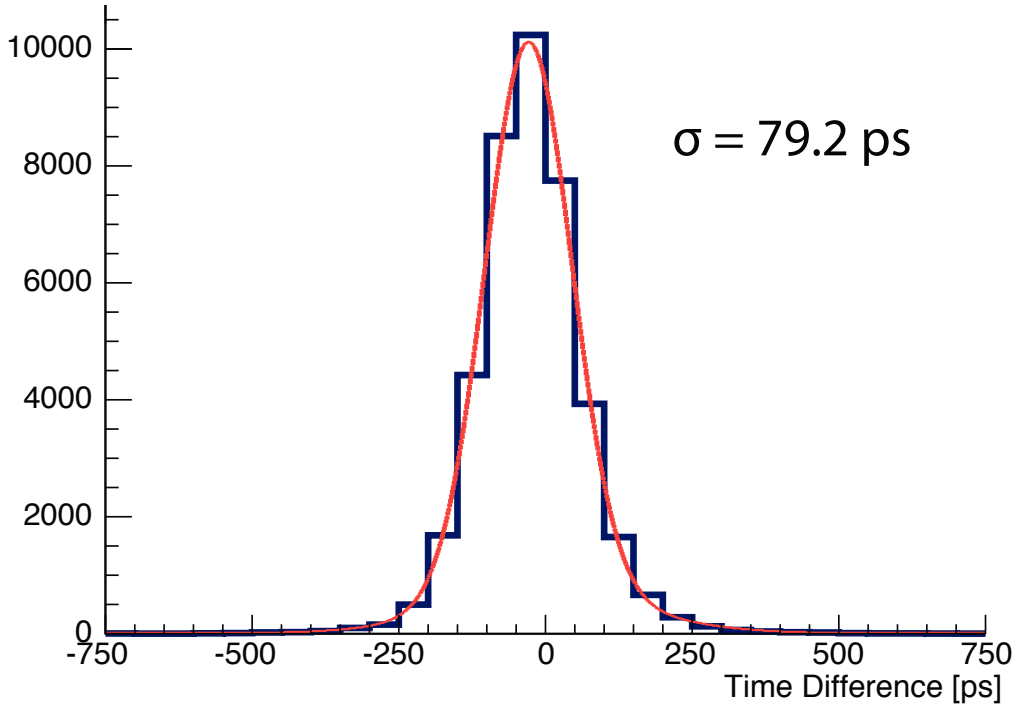


Timing Detector: Scintillating tiles

Front

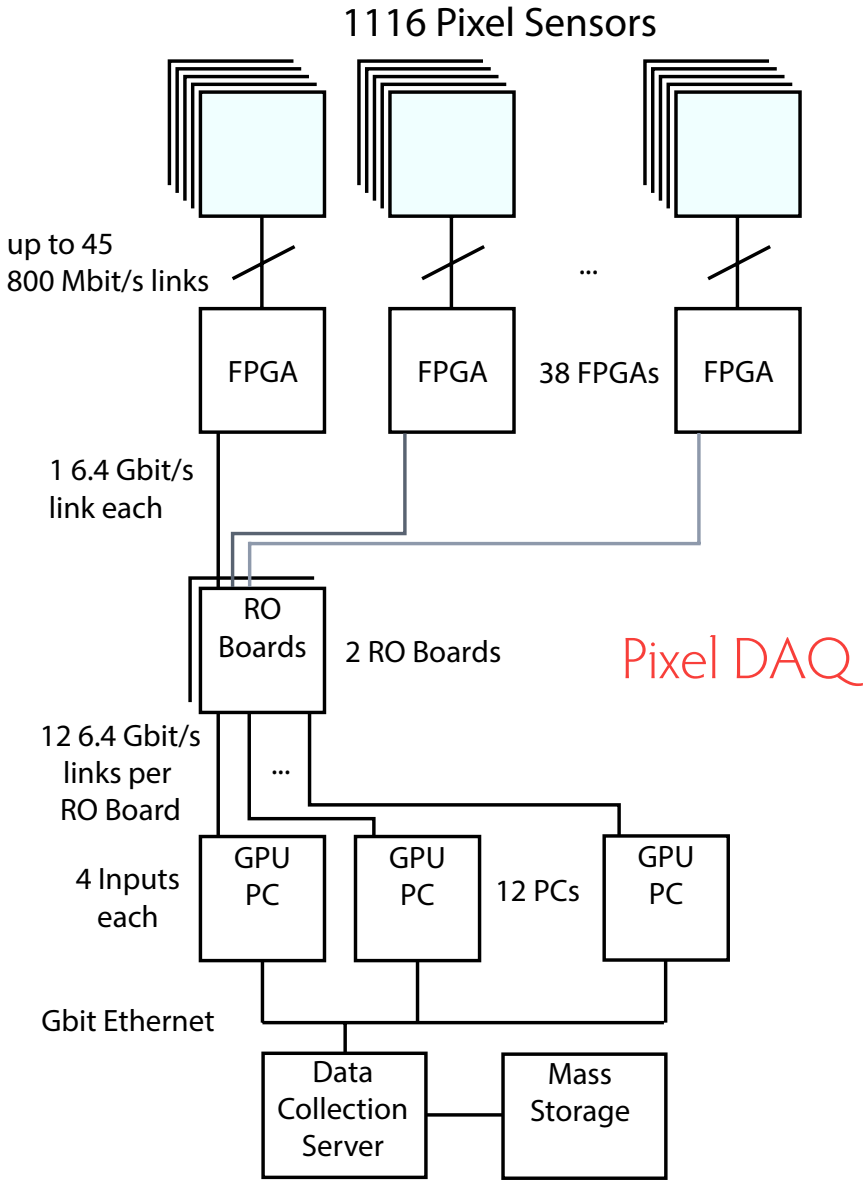


Back



- Test beam with tiles, SiPMs and readout ASIC
- Timing resolution ~ 80 ps

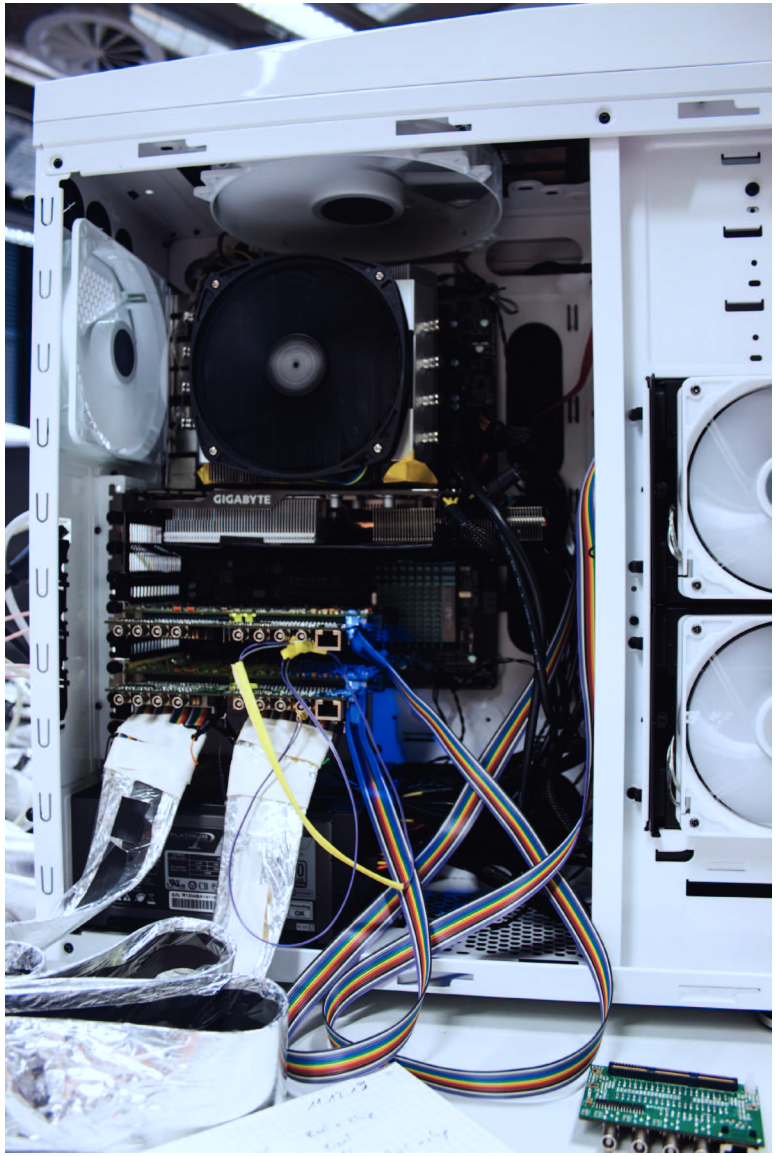
Data Acquisition



Pixel DAQ

- 280 Million pixels (+ fibres and tiles)
- No trigger
- ~ 1 Tbit/s
- FPGA-based switching network
- O(50) PCs with GPUs

Online filter farm

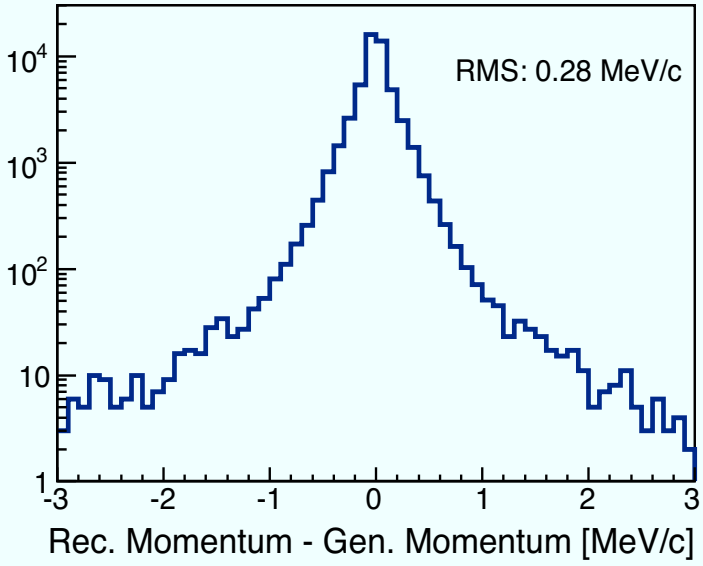


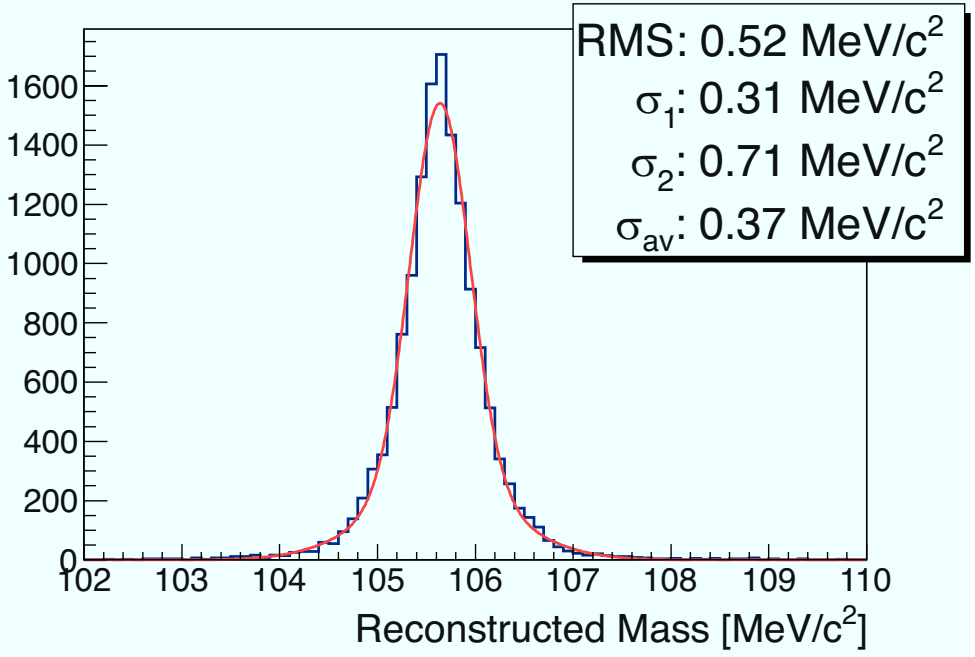
Online software filter farm

- Continuous front-end readout (no trigger)
- ~ 1 Tbit/s
- PCs with FPGAs and Graphics Processing Units (GPUs)
- Online track and event reconstruction
- 10^9 3D track fits/s achieved
- Data reduction by factor ~1000
- Data to tape < 100 Mbyte/s

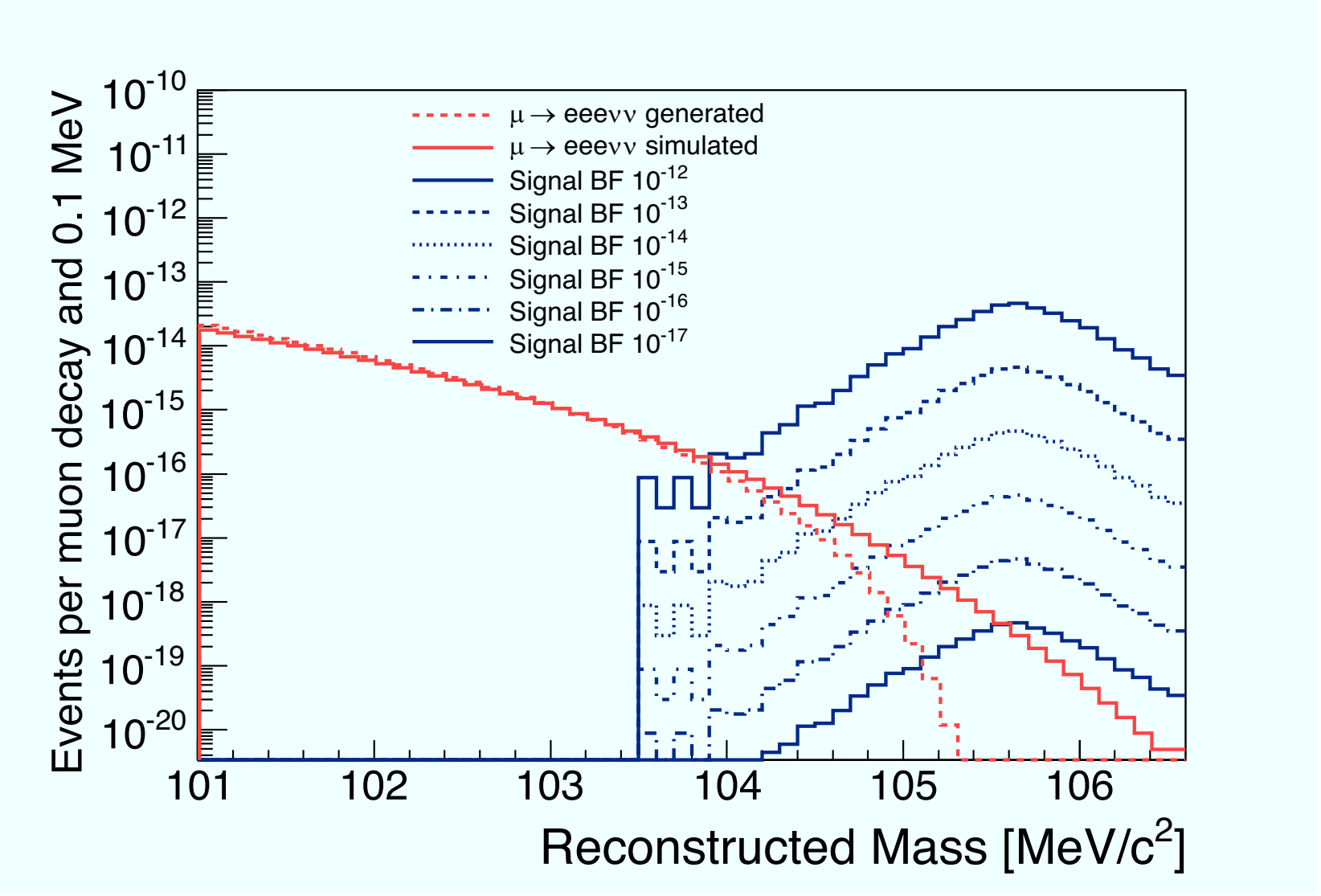
Simulated Performance

- 3D multiple scattering track fit
- Simulation results:
  280 keV single track momentum
  520 keV total mass resolution

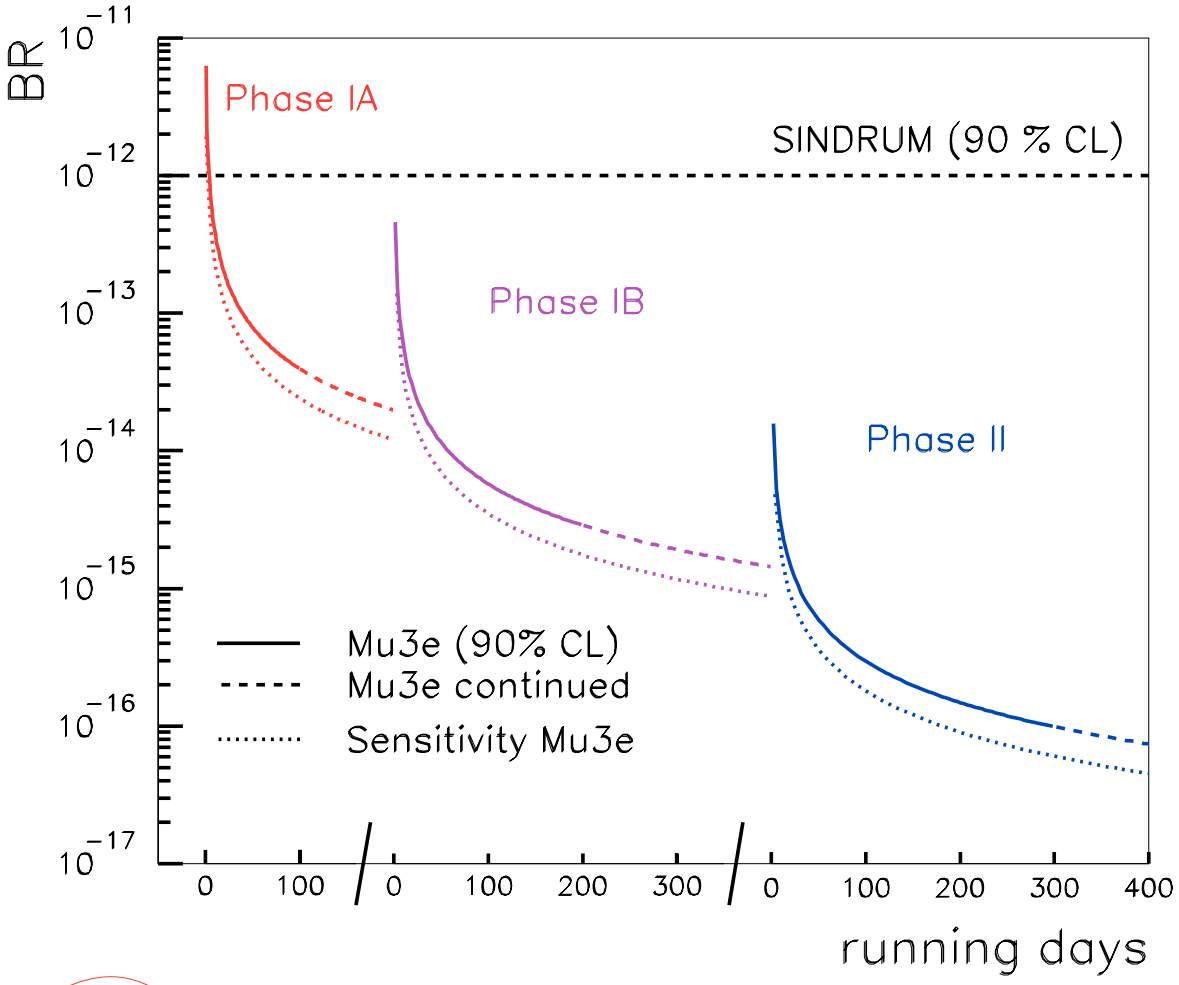


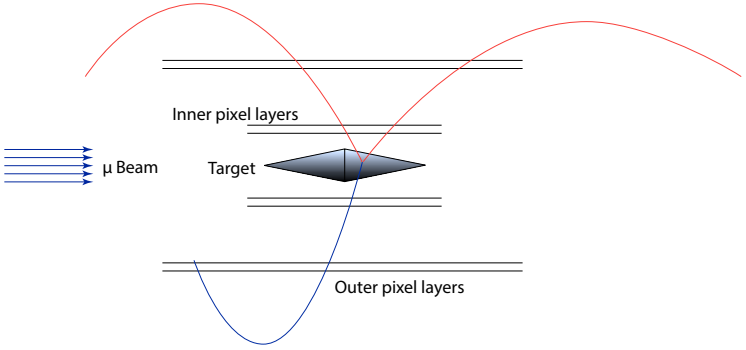


Simulated Performance



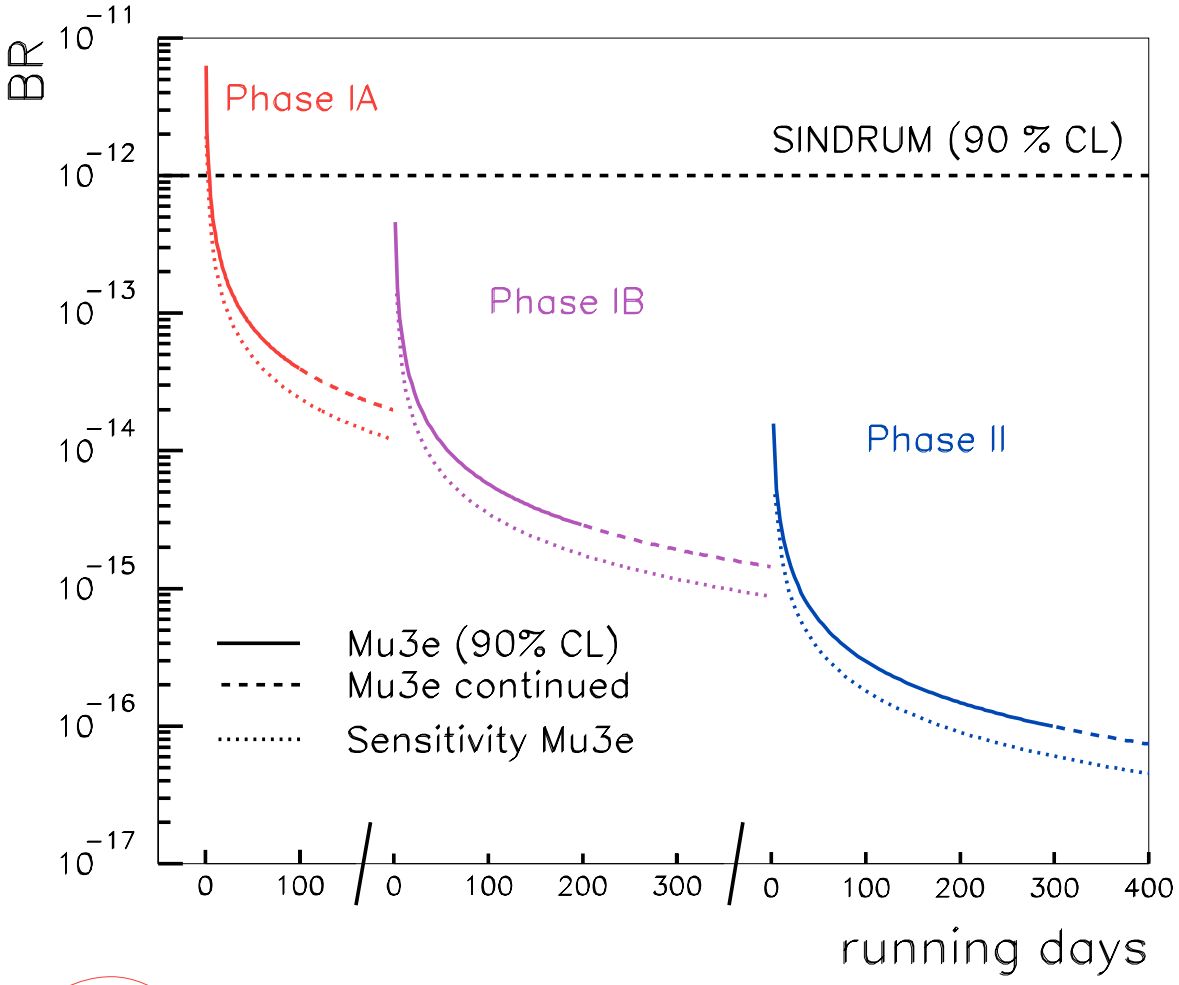
Sensitivity

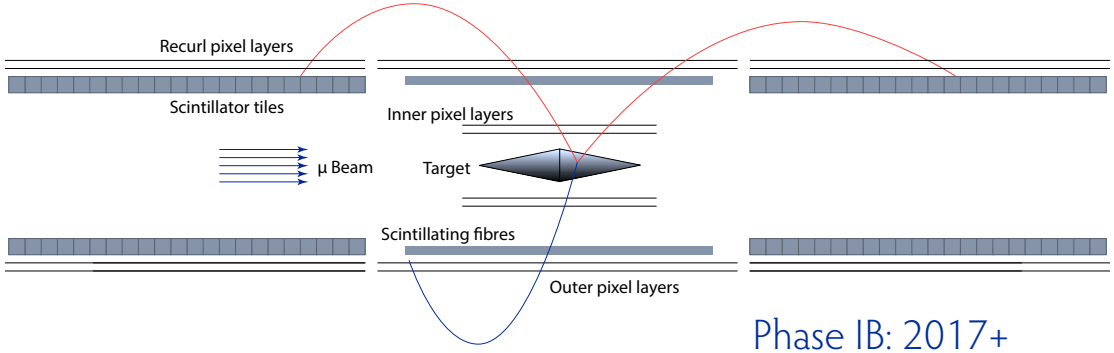




Phase IA: Starting 2016
$2 \cdot 10^7$ μ/s

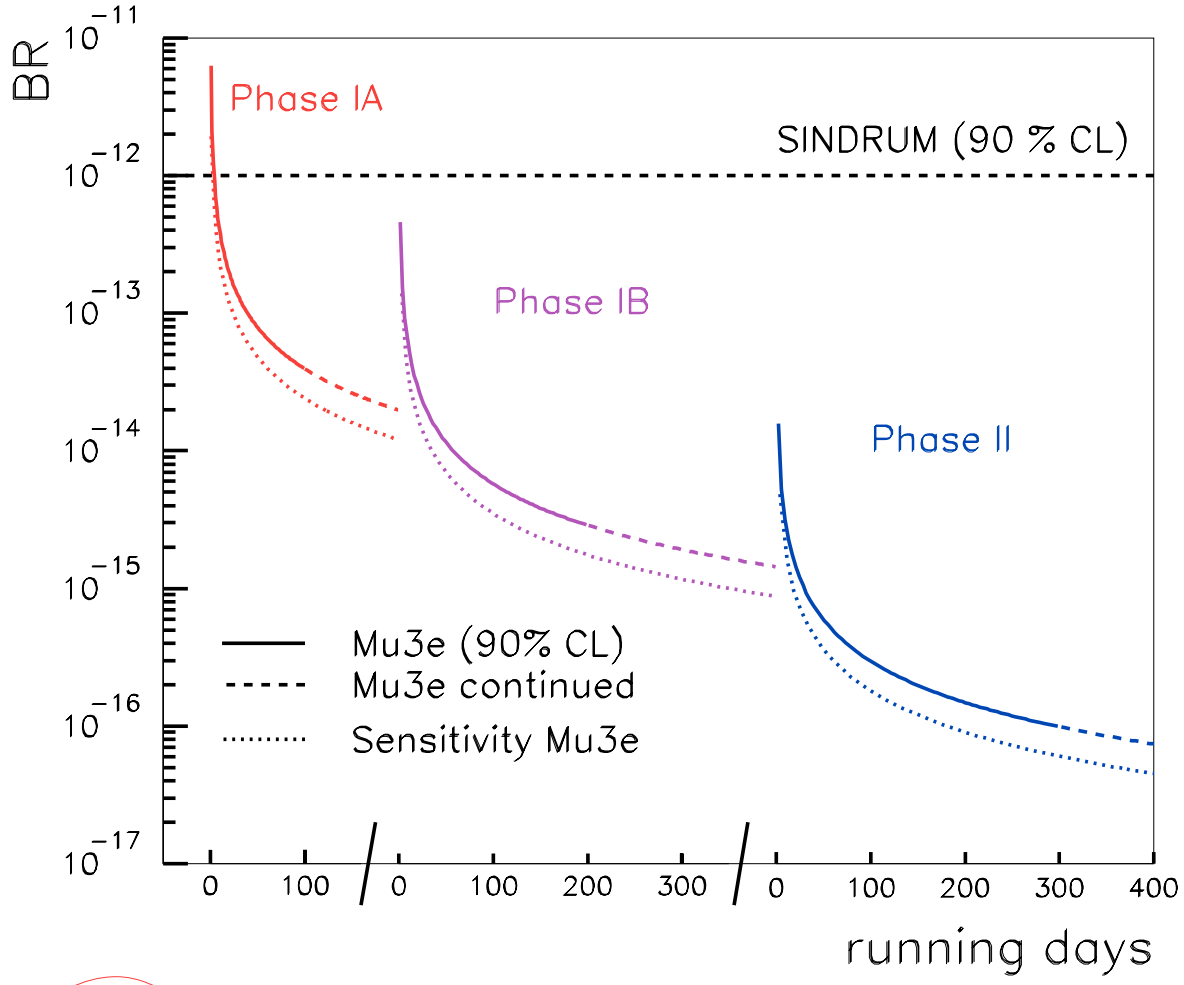
Sensitivity

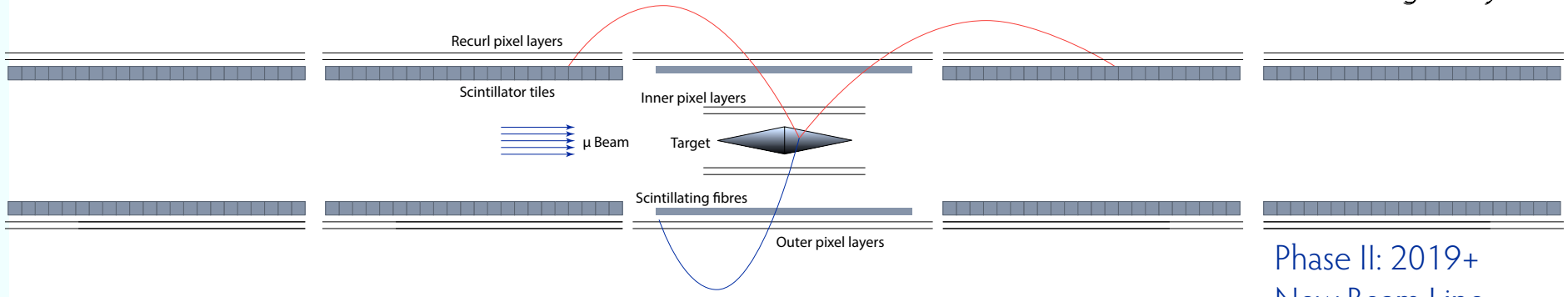




Phase IB: 2017+
$1 \cdot 10^8$ μ/s

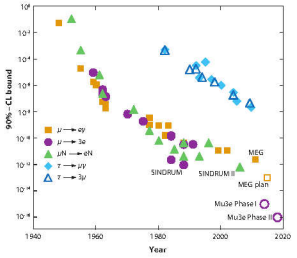
Sensitivity



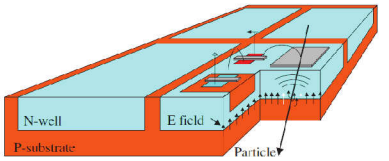


Phase II: 2019+
New Beam Line
$2 \cdot 10^9$ μ/s

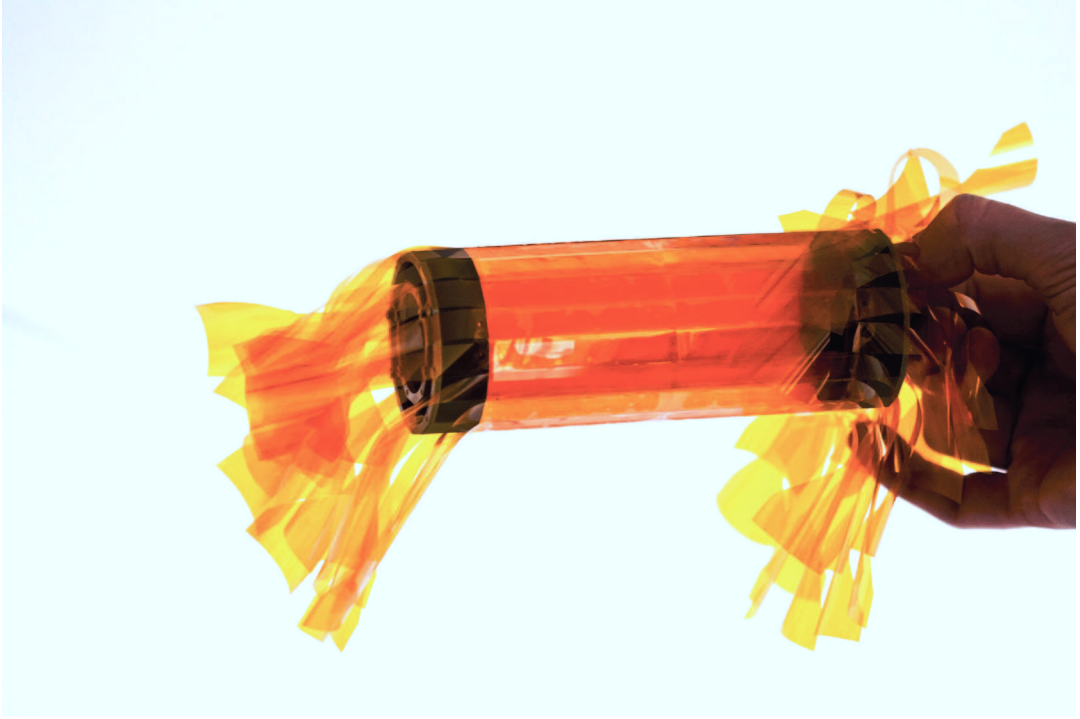
Conclusion



- Mu3e aims for μ → eee at the 10^{-16} level
- First large scale use of HV-MAPS
- Build detector layers thinner than a hair
- Timing at the 100 ps level
- Reconstruct 2 billion tracks/s in 1 Tbit/s on ~50 GPUs
- Start data taking in 2016
- 2 billion muons/s not before 2019

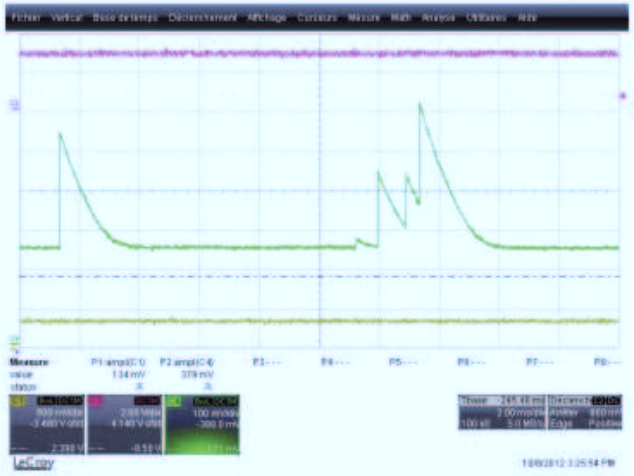


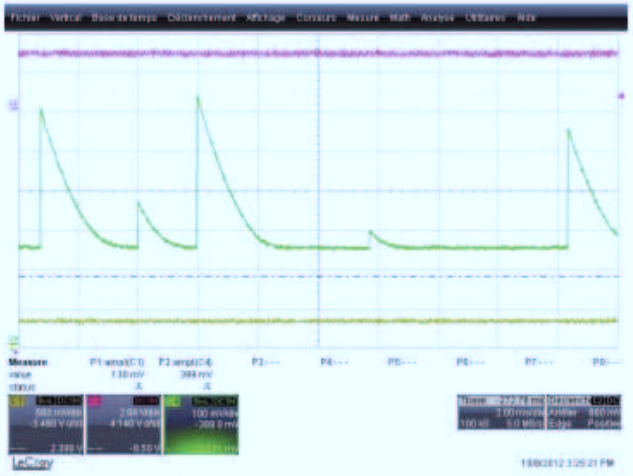
Backup Material



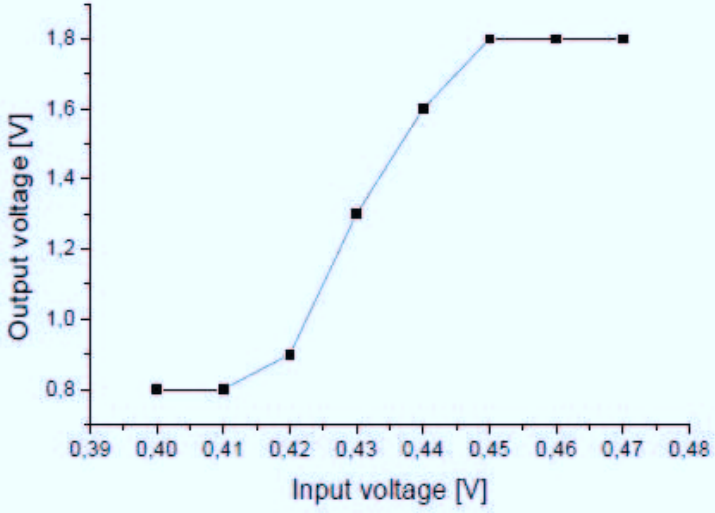
Radiation Hardness

- Requirements not as strict as at LHC





The chip works, particles are measured when the chip is in the beam: Output of the amplifier



Comparator characteristics.

- Irradiation at PS
- After 380 MRad (8×10^{15} n_{eq}/cm^2)
- Chip still working

(Courtesy Ivan Perić, RESMDD 2012)

MUPIX electronics